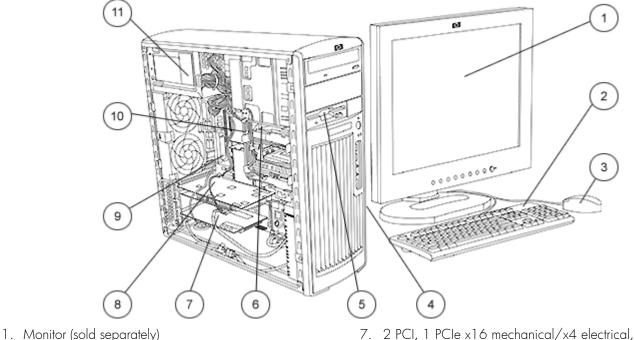
Overview

HP xw6400 Workstation

HP recommends Microsoft® Windows® XP Professional



- 2. 2004 Standard Keyboard (USB or PS2)
- 3. Mouse
- 4. Front IO: 2 USB 2.0, IEEE-1394 (optional), headphone and 10. Dual 64-bit Intel® Xeon® series 5100 processors microphone
- 5. 3.5" external bay for optional diskette drive or other 3.5" device
- 6. 2 internal 3.5" bays, 2 external 5.25" bays

At A Glance

- Choice of operating systems: • Microsoft Windows XP Professional Microsoft Windows XP Professional x64 Edition (see http://www.hp.com/workstations/pws/windowsxp64/ for details)
- Red Hat Enterprise Linux Workstation 3 (32- or 64-bit version as an after market option) •
- Red Hat Enterprise Linux Workstation 4 (32- or 64-bit version)
- HP Linux Installer Kit (see http://www.hp.com/workstations/software/linux/ for details) •
- 64-bit dual-core Intel® Xeon® processors (availability in 2H 2006) •
- 1066 and 1333 MHz Front Side Bus support
- 4-channel 533 or 667 MHz FB-DIMM memory subsystem
- Up to 16 GB memory capacity
- PCI Express I/O and graphics
- Integrated Broadcom 5752 Gigabit ethernet



- 7. 2 PCI, 1 PCIe x16 mechanical/x4 electrical, 2 PCIe x8 mechanical/x4 electrical
- 8. 1 PCI Express x16 Graphics Bus
- 9. 5 USB 2.0 (rear), 1 USB 2.0 (internal), 1 standard serial port, 1 parallel port, 2 PS/2, 1 RJ-45, audio in/out
- (availability in 2H 2006)
- 11.575 watt power supply

Overview

- 4 channels of Serial ATA (SATA) 3 Gb/s natively supported internally; RAID level 0, 1 available on motherboard (HW RAID functionality not supported by Linux)
- High Definition integrated audio with internal speaker
- Pre-loaded Manageability tools
- Energy Star compliance with energy-saving features (Not supported by Linux)
- Protected by HP Services, including a 3 years next business day onsite standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply.



Standard Features - Custom Components

Processor and speed – Up to 2 of the following	Dual Core Intel Xeon processor with EM64T One or two Dual Core Intel Xeon Processor 5100 Sequence*, 4 MB shared L2 cache per processor 1.60 GHz/1066 2.00 GHz/1333 2.33 GHz/1333 2.66 GHz/1333 3.00 GHz/1333 * Dual Core Intel Xeon Processor 5100 Sequence available 2H 2006				
Operating System – One of the following	Microsoft Windows XP Professional SP2 Microsoft Windows XP Professional x64 Edition (expected avail	ability with Intel Xeo	n processor 5100		
	sequence only in 2H 2006)				
	Red Hat Enterprise Linux Workstation 3 (32 & 64-bit available of Red Hat Enterprise Linux Workstation 4 (32 & 64-bit available of Option)		,		
	See http://www.hp.com/workstations/software/linux/ Click on "Hardware support matrix" under "Related links" for det	ails.			
1-3 Hard Disk Drives –		Windows XP	Red Hat Linux		
Up to 3 of the following	80 GB 7200 rpm SATA 3 Gb/s drive	32-bit, 64-bit	WS3, WS4		
SATA drives, or 3 of the	160 GB 7200 rpm SATA 3 Gb/s NCQ drive	32-bit, 64-bit	WS3, WS4		
following SAS drives	250 GB 7200 rpm SATA 3 Gb/s NCQ drive	32-bit, 64-bit	WS3, WS4		
	500 GB 7200 rpm SATA 3 Gb/s NCQ drive	32-bit, 64-bit	WS3, WS4		
	146 GB 10,000 rpm SAS 3 Gb/s drive	32-bit, 64-bit	WS3, WS4		
	73 GB 15,000 rpm SAS 3 Gb/s drive	32-bit, 64-bit	WS3, WS4		
	146 GB 15,000 rpm SAS 3 Gb/s drive	32-bit, 64-bit	WS3, WS4		
Factory integrated		Windows XP	Red Hat Linux		
RAID on motherboard for	RAID 0 Configuration – Striped Array	32-bit, 64-bit	Not supported		
SATA drives	RAID 1 Configuration – Mirrored Array	32-bit, 64-bit	Not supported		
	RAID 10 Configuration – Striped/Mirrored Array	32-bit, 64-bit	Not supported		
	RAID 5 Configuration – Parity Array NOTE: Requires 2 identical hard drives (speeds, capacity, interface)	32-bit, 64-bit	Not supported		
Drive controllers		Windows XP	Red Hat Linux		
	Integrated SATA 3 Gb/s controller, RAID level 0, 1, 10, 5 supported	32-bit, 64-bit	WS3, WS4 (HW RAID functionality not supported by Linux)		



Standard	Features	- Custom	Components
Janadia	r carbres	CUSICIII	components

	IEEE 1394a FireWire 4-Port PCI Card	32-bit, 64-bit	Not Supported
	IEEE 1394b FireWire 4-Port PCI Card	32-bit, 64-bit	Not Supported
Memory –		Windows XP	Red Hat Linux
One of the following	512 MB PC2-5300F ECC registered DDR2 667 MHz FB-DIMM (1 x 512 MB)	32-bit, 64-bit	WS3, WS4
	1 GB PC2-5300F ECC registered DDR2 667 MHz FB-DIMM (2 x 512 MB)	32-bit, 64-bit	WS3, WS4
	2 GB PC2-5300F ECC registered DDR2 667 MHz FB-DIMM (4 x 512 MB)		WS3, WS4
	2 GB PC2-5300F ECC registered DDR2 667 MHz FB-DIMM (2 x 1 GB)	32-bit, 64-bit	WS3, WS4
	3 GB PC2-5300F ECC registered DDR2 667 MHz FB-DIMM (2 x 1GB + 2 x 512 MB)	32-bit, 64-bit	WS3, WS4
	4 GB PC2-5300F ECC registered DDR2 667 MHz FB-DIMM (4 x 1 GB)	32-bit, 64-bit	WS3, WS4
Removable storage		Windows XP	Red Hat Linux
	1.44-MB Diskette Drive	32-bit, 64-bit	WS3, WS4
	48X CD-ROM Drive	32-bit, 64-bit	WS3, WS4
	16X/40X DVD-ROM drive	32-bit, 64-bit	WS3, WS4
	48X/32X/48X/16X Combo CD-RW/DVD-ROM Drive	32-bit, 64-bit	WS3, WS4
	16X DVD+/-RW, Dual-Layer, LightScribe (Windows)	32-bit, 64-bit	WS3, WS4
2nd Removable storage		Windows XP	Red Hat Linux
	16X/40X DVD-ROM drive	32-bit, 64-bit	WS3, WS4
	48X/32X/48X/16X Combo CD-RW/DVD-ROM Drive	32-bit, 64-bit	WS3, WS4
	16X DVD+/-RW, Dual-Layer, LightScribe (Windows)	32-bit, 64-bit	WS3, WS4
Keyboard -		Windows XP	Red Hat Linux
One of the following	PS/2 Standard Keyboard	32-bit, 64-bit	WS3, WS4
	USB Standard Keyboard	32-bit, 64-bit	WS3, WS4
Mouse –		Windows XP	Red Hat Linux
One of the following	PS/2 2-Button Scroll Mouse	32-bit, 64-bit	WS3, WS4
	USB 2-Button Optical Scroll Mouse	32-bit, 64-bit	WS3, WS4
	USB 3-Button Optical Mouse	32-bit, 64-bit	WS3, WS4
Audio		Windows XP	Red Hat Linux



Standard Features	- Custom Components		
	Integrated High Definition audio with internal speaker * Via linux drivers on HP support website that are not part of RHEL WS 3	32-bit, 64-bit	WS3, WS4
	SoundBlaster X-Fi XtremeMusic audio card	32-bit	Not Supported
NIC		Windows XP	Red Hat Linux
	Integrated Broadcom BCM5752 Gigabit LOM,	32-bit, 64-bit	WS3, WS4
	Broadcom BCM5751 NetXtreme Gigabit Ethernet Controller (PCI-E)	32-bit, 64-bit	WS3, WS4
Graphics		Windows XP	Red Hat Linux
	NVIDIA Quadro NVS 285 PCI Express with NVIDIA TurboCache Technology	32-bit, 64-bit	WS3, WS4
	NVIDIA Quadro NVS 440 256 MB PCI Express	32-bit, 64-bit	Not supported
	NVIDIA Quadro FX 560 128 MB PCI Express	32-bit, 64-bit	WS3, WS4
	ATI FireGL V3300 128 MB PCI Express	32-bit, 64-bit	WS3, WS4
	NVIDIA Quadro FX 1500 256 MB PCI Express	32-bit, 64-bit	WS3, WS4
	NVIDIA Quadro FX 3500 256 MB PCI Express	32-bit, 64-bit	WS3, WS4
	ATI FireGL V7200 256 MB PCI Express	32-bit, 64-bit	WS3, WS4
Software		Windows XP	Red Hat Linux
	Optional Symantec Norton AntiVirus (optional)	32-bit, 64-bit	Not supported
	Optional Microsoft Office 2003 Basic	32-bit, 64-bit	Not supported
	Optional Microsoft Office 2003 Pro	32-bit, 64-bit	Not supported
	Optional Microsoft Office 2003 Small Business	32-bit, 64-bit	Not supported
	HP Performance Tuning Framework	32-bit, 64-bit	Not supported
	HP Client Manager Software v6.0 (expected availability in 2H 2006)	32-bit, 64-bit	Not supported
	Optional HP Protect Tools Security Solutions	32-bit, 64-bit	Not supported



Standard Features - Specs

Operating System (choice)	Microsoft Windows XP Professional SP2
	Microsoft Windows XP Professional x64 Edition (expected availability in 2H 2006)
	OR Red Hat Enterprise Linux Workstation 4 64 bit preload (32 bit version included on recovery CD or as after market option)
	OR Red Hat Enterprise Linux Workstation 3 (32 bit and 64 bit) available as an after market option.
	OR HP Installer Kit for Linux (includes drivers for both 32-bit & 64-bit OS versions of RHEL 3 and RHEL 4)
Form factor	Minitower
Color	Carbonite/Alloy metallic
System board form factor	12"x9.8"
Processor	1 or 2 Dual-Core Intel® Xeon® Processor 5100 sequence with EM64T (expected availability in 2H 2006)
CPU FSB	667, 1066, 1333 MHz
Standard L2 cache	2 MB L2 inclusive cache (non ECC) per core, 4 MB total shared cache per processor
Chipset	Intel® 5000X
Memory expansion slots	4 DIMMs
Memory type supported	DDR2 registered ECC FB-DIMMs
Memory speed supported	
Maximum memory	16 GB (4 DIMMs slots with 4 GB DIMMS)
, Network controller	Integrated Broadcom 5752 Gigabit Ethernet LAN-On-Motherboard
Audio	Integrated high definition digital audio with S/PDIF 6-channel pass-through, stereo microphone, and Yamaha XG Lite Softsynth support If using RHEL WS 3, the audio drivers are not included as part of the standard RHEL WS 3 operating system. Use the ALSA audio drivers included on the HP Driver CD or from the HP support website. See <u>http://www.hp.com/support/linux_hardware_matrix</u> and <u>http://www.hp.com/support/linux_user_manual</u> for details.
PCI slots	2 PCI slots (full-length) 2 PCI Express (x8 mechanically, x4 electrically) 1 PCI Express (x16 mechanically/x4 electrically) 1 PCI Express x16 graphics
Bays	Total Bays = 5
Internal bays	Two 3.5 inch HDD bays with acoustic dampening rail assemblies
External bays	 Two 5.25 inch bays - 203 mm maximum device depth (top bay is limited to 198 mm depth when optional smart cover solenoid lock is installed). Bottom bay can be converted to an internal 3.5 inch 3rd Hard Drive bay using optional bracket One 3.5 inch bay for optional floppy drive
Front I/O	2 USB 2.0, Headphone, Microphone, optional IEEE 1394 NOTE: Although HP Personal Workstations can be ordered with the HP Installer Kit for Linux and an IEEE 1394 card, HP cannot provide customer support for this configuration. Please refer to the Linux Hardware Support Matrix (<u>http://www.hp.com/support/linux_hardware_matrix</u>) for details, and to the Linux User Manual (<u>http://www.hp.com/support/linux_user_manual</u>) for tips on user-enablement of the IEEE 1394 Card.
Internal I/O	1 USB 2.0 header
Rear I/O	5 USB 2.0, 1 standard serial port, 1 parallel port, PS/2 keyboard and mouse, 1 RJ-45 to integrated Gigabit LAN, Audio In, Audio Out, Microphone In
USB keyboard	Optional



Standard Features - Specs

USB mouse	Optional			
PS/2 keyboard	1			
PS/2 mouse	1			
Chassis dimensions	17.3 x 6.5 X 17.3 in (44.	1 x 16.5 x 44.0 cm)		
$(H \times W \times D)$				
System weight	Minimum config – 14.60 ł			
	Maximum config – 18.11	KG (39.94 lbs)		
Temperature	Operating	40° to 95° F (5° to 35° C)		
	Non-operating	-40° to 140° F (-40° to 60° C)		
Humidity	Operating	8% to 85%		
	Non-operating	8% to 90%		
Maximum altitude	Operating	10,000 ft (3,000 m)		
(nonpressurized)	Non-operating	30,000 ft (9,100 m)		
Power supply	575W wide-ranging, active Power Factor Correction			
Interfaces supported	4-channel SATA interface (4 serial-ATA connectors each), 2 EIDE interface (2 EIDE connectors)			
	supported for optical drives, USB 2.0, IEEE 1394 (optional)			
Hard drive controller (PCI)	SATA or optional SAS controllers			
Supported				



After-Market Options

Processors		2 nd dual core Intel Xeon® processor with Hyper-Threading technology, EM64T, and 2 MB of L2 cache per core (4 MB L2 cache in total)						
	1.60 GHz with 1066 MHz FSB *	EY012AA						
	1.86 GHz with 1066 MHz FSB *				EY013AA			
	2.00 GHz with 1333 MHz FSB *				EY014AA			
	2.33 GHz with 1333 MHz FSB *				EY015AA			
	2.66 GHz with 1333 MHz FSB *				EY016AA			
	3.00 GHz with 1333 MHz FSB *				EY017AA			
	* Expected availability in 2H 2006							
Graphics	Multi display solutions	PCI Express	Windows XP	Red Hat Linux	Part Number			
·	NVIDIA Quadro NVS 285 (64 MB, VGA & DVI)	Х	32-bit, 64-bit	WS3, WS4	EE061AA			
	NVIDIA Quadro NVS 440 (256 MB)	Х	32-bit, 64-bit	Not supported	PT453A			
	NVIDIA Quadro FX 560 (128 MB)	Х	32-bit, 64-bit	WS3, WS4	ES354AA			
	ATI FireGL V3300 (128 MB)	Х	32-bit, 64-bit	WS3, WS4	es353aa			
	NVIDIA Quadro FX 1500 (256 MB)	Х	32-bit, 64-bit	WS3, WS4	es355aa			
	NVIDIA Quadro FX 3500 (256 MB)	Х	32-bit, 64-bit	WS3, WS4	es357aa			
	ATI FireGL V7200 (256 MB)	Х	32-bit, 64-bit	WS3, WS4	es356AA			
Hard drives	SATA Hard Drives		Windows XP	Red Hat Linux	Part Number			
	80 GB 7200 rpm SATA 3 Gb/s dri	ve	32-bit, 64-bit	WS3, WS4	DX760A			
	160 GB 7200 rpm SATA 3 Gb/s N	160 GB 7200 rpm SATA 3 Gb/s NCQ drive						
	250 GB 7200 rpm SATA 3 Gb/s N	VCQ drive	32-bit, 64-bit	WS3, WS4	EA788AA			
	500 GB 7200 rpm SATA 3 Gb/s N	VCQ drive	32-bit, 64-bit	WS3, WS4	PV943A			
	SAS Hard Drives							
	146 GB 10,000 rpm SAS 3 Gb/s	drive	32-bit, 64-bit	WS3, WS4	EM173AA			
	73 GB 15,000 rpm SAS 3 Gb/s d	rive	32-bit, 64-bit	WS3, WS4	EA329AA			
	146 GB 15,000 rpm SAS 3 Gb/s	drive	32-bit, 64-bit	WS3, WS4	EA330AA			
	StorCase SATA removable drive enc (1 additional HD in a 5.25 inch bay		NA	NA	EA332AA			
Controllers		PCI PCI- Express	Windows XP	Red Hat Linux	Part Number			
	Controllers	I						
	IEEE 1394a FireWire 4-Port PCI Card	Х	32-bit, 64-bit	Not supported	PA997A			
	IEEE 1394b FireWire 4-Port PCI Card	Х	32-bit, 64-bit	Not supported	EA327AA			



After-Market Options

Input/output devices				Windows XP	Red Hat Linux	Part Number
	Keyboards					
	HP PS/2 Standard Keyboard (Carbo	nite/Sil	ver)	32-bit, 64-bit	WS3, WS4	DT527A
	HP USB Standard Keyboard (Carbonite/Silver) 3			32-bit, 64-bit	WS3, WS4	DT530A
	HP USB Smartcard Keyboard			32-bit, 64-bit	Not supported	ED707AA
	Pointing Devices					
	HP PS/2 2-Button Scroll Mouse (Carb	oonite)		32-bit, 64-bit	WS3, WS4	DD440B
	HP USB 2-Button Optical Scroll Mouse (Carbonite/Silver)	e		32-bit, 64-bit	WS3, WS4	DC172B
	HP USB Optical 3-button mouse			32-bit, 64-bit	WS3, WS4	DY651A
	USB Spaceball 5000			32-bit, 64-bit	Not supported	DV675A
	USB SpaceMouse			32-bit, 64-bit	Not supported	DZ203A
	USB SpacePilot			32-bit, 64-bit	Not supported	EF390AA
Networking	NICs	PCI	PCI- Express	Windows XP	Red Hat Linux	Part Number
	Broadcom BCM5751 NetXtreme Gigabit Ethernet Controller (PCle)		Х	32-bit, 64-bit	WS3, WS4	DZ556A
Memory modules				Windows XP	Red Hat Linux	Part Number
	667 MHz 512 MB PC2-5300F ECC registered MHz FB-DIMM	DDR2	667	32-bit, 64-bit	WS3, WS4	EM159AA
	1 GB PC2-5300F ECC registered DDR2 667 MHz FB-DIMM			32-bit, 64-bit	WS3, WS4	EM160AA
Monitors (Supported by	all TFT display					
Operating Systems	HP Flat Panel Monitor TFT LP2465 (2-	4 -inch)				EF224A4
available from HP)	HP Flat Panel Monitor TFT L2065 (20	.1-inch				EF227A4
	HP Flat Panel Monitor TFT L1955 (19	.1-inch				PD974A5
Optical drives				Windows XP	Red Hat Linux	Part Number
	DVD-ROM Drive					
	16X/40X DVD-ROM w/ +R read			32-bit, 64-bit	WS3, WS4	AA620B
	CD-ROM Drive 48X Max CD-ROM Drive (only availa optical drive)	ble as [.]	irst	32-bit, 64-bit	WS3, WS4	DC143B
	Combo Drive					
	48X/32X Combo DVD-ROM/CD-RV	V Drive		32-bit, 64-bit	WS3, WS4	DE206A



After-Market Options

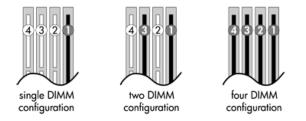
	DVD+/-RW Drive			
	16X DVD+/-RW, Dual-Layer, LightScribe (Windows 2K and XP only)	32-bit	WS3, WS4 (LightScribe functionality not supported)	DZ555A
Removable storage		Windows XP	Red Hat Linux	Part Number
	512 MB USB 2.0 drive key	32-bit, 64-bit	WS3, WS4	ED516AA
	1 GB USB 2.0 drive key	32-bit, 64-bit	WS3, WS4	AG382AA
	1.44 MB Internal Floppy Drive	32-bit	WS3, WS4	DY670A
Audio	HP Satellite Stereo Speakers			DE893D
	SoundBlaster X-Fi XtremeMusic audio card	32-bit, 64-bit	Not supported	EA326AA
Brackets/stands	xw64 Depth Adjustable Sliding Rail Rack Kit			DY663A
	HP Optical Bay HDD Mounting Bracket			DY659A
	HP 1U Fixed Rack Shelf			253449-B21
	HP 100Kg 1U Sliding Rack Shelf			234672-B21
	HP Depth Adjustable Fixed Rail Rack Kit			332558-B21
Other devices	HP Internal USB Port Kit			EM165AA
	HP Power Cord Kit			DM293A
	"PCI Front Card Guide/Fan Kit			EM163AA
Operating systems	Red Hat Enterprise Linux Workstation 4 (64-bit prelo	ad)		EA700AA



Memory

Intel 5000X chipset PC2-5300F ECC registered DDR2 667 MHz FB-DIMM

The Intel 5000X chipset supports ECC Registered DDR2 667 MHz FB-DIMMs only. The motherboard has 4 DIMM slots. Use only fully buffered, PC2-5300F DIMMs. Match multiple DIMMs by size and type. Use HP memory only.



If only using 1 DIMM, install in socket 1. If using 2 DIMMs, install them in sockets 1 & 3. If using 4 DIMMs, install them in all sockets.

MAXIMUM MEMORY

Supports up to 16 GB of DDR2 FB-DIMM SDRAM.

POSSIBLE MEMORY CONFIGURATIONS

Not all memory configurations possible are represented below.

This chart does not represent all possible memory configurations

DIMM Size				
	1	2	3	4
256 MB				
512 MB				
512 MB	512 MB			
1 GB				
1 GB	512 MB	512 MB		
1 GB				
2 GB	1 GB	1 GB		
2 GB	512 MB	512 MB	512 MB	512 MB
4 GB	1 GB	1 GB	1 GB	1 GB
8 GB	2 GB	2 GB	2 GB	2 GB
16 GB	4 GB	4 GB	4 GB	4 GB



HP xw6400 Workstation

QuickSpecs

Storage

Tower configuration	n
	-1
	-2
	4
	-5
	6

	Quantity Supported	Position Supported	Controller
Convertible minitower			
Optional diskette drive	1	3	IDE
5.25" storage drive bays (position 1 drive bay is limited to 198 mm depth when optional smart cover solenoid lock is installed; position 2 drive bay can be converted to an internal 3.5" 3rd hard drive bay with optional bracket)	2	1, 2	IDE
3.5" storage drive bays with acoustic dampening rail assemblies	2 (3)	5 (and 2, for 3rd drive using optical bay)	SATA or optional SAS Factory Integrated RAID* SATA and SAS may be mixed only in a Windows configuration and with the inclusion of an optional SAS controller. Here are the rules for mixing hard drives: 1) The boot/data drive must be SATA to load before any SAS drive. 2) Any size or speeds may be chosen for drives In non-mixed Microsoft Windows and Linux systems, rules 2 & 3 apply.

Configure-to-order RAID configs must all have the same size/speed hard drives.

Storage

Up to 4 channels of SATA can be supported natively.

* NOTE: Factory Integrated RAID 0 Configuration (Striped Array) and RAID 1 Configuration (Mirrored Array) requires 2 hard drives with identical speeds, capacity and interface. Also, HW RAID functionality or factory configured RAID not supported in Linux. For RAID functionality, use SW RAID provided in the Red Hat operating system instead.



System board		
Processor architecture	Dual-Core Intel® Xeon® Processor 5100 sequence (expected availability in 2H 2006)	
Chipset	Intel® 5000X	
Super I/O controller	SMSC SCH5307	
System board form factor	9.8"x12.0"	
Processor socket	Dual LGA 771	
DIMM connectors (FBD DDR2)	4	
PCI connectors (5.0V)	2 full length 33 MHz 32-bit	
PCI express connectors	1 PCI Express x16 graphics 2 PCI Express (x8 mechanically, x4 electrically) 1 PCI Express (x16 mechanical/x4 electrically)	
Flash ROM	Yes	
HD integrated audio	Yes	
CD-ROM IN (audio)	No	
AUX IN (audio)	Yes	
Clear CMOS button	Yes	
CPU fan headers	Yes	
Chassis fan headers	Yes	
Front control panel/speaker header	Yes	
CMOS battery holder – Lithium	Yes	
Hood lock header	No	
Hood sensor header	No	
Multibay header	No	
Integrated SATA RAID	 RAID 0, RAID 1, RAID 5 and RAID 10 Supports one RAID array with 2-4 drives RAID 0 configuration – striped array RAID 1 configuration – mirrored array RAID 5 parity striping RAID 10 stripe of mirrors NOTE: HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead. 	
Integrated Gigabit Ethernet	Broadcom BCM5752	
Wake on LAN	Yes	
Integrated Trusted Platform Module	TPM 1.2 expected availability for systems sold at end of 2006/ early 2007	
ASF 2.0 (Alert Standard Format)	Yes	
SATA connectors	4 ports/connectors	



IEEE 1394a connectors	No integrated 1394a - optional PCI card required. Cable from Front IO can be plugged into PCI Card. Not supported in Linux
USB 2.0 connectors	8 (5 rear, 2 on header for front, 1 internal)
Power supply headers	Yes
Power switch, power LED	Yes
& hard drive LED header	
a nura unve LED header	
Password clear header	Yes
	103

Cooling solutions	
Power supply fan	92 mm × 25 mm
Processor heatsink fan(s)	80 mm x 15 mm
Rear chassis fan(s)	One 92 mm x 25 mm and one 92 mm x 32 mm

Power supply		
Power supply	575 W watt custom power supply –	
	(Wide Ranging, Active PFC)	
Operating voltage range	90 – 269 VAC	
Rated voltage range	100 – 240 VAC	118 VAC
Rated line frequency	50/60 Hz	400Hz
Operating line frequency	47 – 66 Hz	393-407 Hz
range		
Rated input current	8A @ 100-120VAC 4 A @ 200-240 VAC	7.8 @ 118 VAC
Heat dissipation	Typical 699 btu/hr (176 kg-cal/hr)	
(configuration and	Typical 699 btu/hr (176 kg-cal/hr) Maximum 1962 btu/hr (495 kg-cal/hr)	
software dependent)		
Power supply fan	92x25 mm variable speed	
Energy Star compliant	YES	
Blue Angel compliant	N/A	
(<5w in S5 – power off)		
FEMP Standby power	YES	
compliant @115V		
(<2W in S5 – power off)		
Power consumption in ES	< 7 W	
mode – Suspend to RAM		
(S3) (instantly available PC)		

ROM Features	Description
ROM based F10 setup	Review and customize BIOS settings
and diagnostics	
Remote system installation	Allows a new or existing system to boot over the network and download software, including the
via F12 (PXE) (remote boot	operating system
from server)	
System/emergency ROM	Recovers corrupted system BIOS
flash recovery with video	
ROM revision levels	Identifies system ROM revision levels and reports in ROM-based F10 setup



	Version is stored in an industry standard memory location (SMBIOS) so that management SW applications can use and report this information
System board revision	Allows management SW to read the revision level of the system board
level	Revision level is digitally encoded into the hardware and cannot be modified
Auto setup when new hardware Installed	System automatically detects addition of new hardware
	Enable or disables serial, parallel, USB, audio, and network ports
boot control	Prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On password	Prevents an unauthorized person from booting up the computer
Setup password	Prevents an unauthorized person from changing the system configuration
Replicated setup	Saves BIOS settings to diskette or USB disk-on-key in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering ROM-based F10 setup
Memory change alert (requires HP Client Manager Software)	Alerts management console if memory is removed or changed
Thermal alert (requires HP Client Manager Software)	 Monitors the temperature state within the chassis. Three modes: NORMAL – normal temperature ranges ALERTED – excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown SHUTDOWN – excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs
Master Boot record Security	Detects changes to MBR and optional restoration, useful in protecting from viruses
Remote ROM flash	Provides secure, fail-safe ROM image management from a central network console
Remote Wakeup/shutdown	 System administrators can power on, restart, and power off a client computer from a remote location. Enables cost-effective power consumption when the administrator needs to distribute software, perform security management, or update the ROM
ACPI (Advanced Configuration and Power Interface)	 Allows the system to wake from a low power mode Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system Supports ACPI 2.0 for full compatibility with 64-bit operating systems
Keyboard-less operation	The system can be operated without a keyboard
SMBIOS	System Management BIOS 2.3.5, previously known as DMI BIOS, for system management information
Localized ROM setup	Common BIOS image supports configuration (Setup) in 11 languages, with local keyboard mappings
Asset tag	Allows user or MIS to set unique tag string in ROM
Ownership tag	Allows user or MIS to set unique tag string in ROM
Memory scrubbing	Allows memory controller to transparently correct transient ECC errors in the background
	Allows system memory lost to PCI devices to be reclaimed above 4 GB, for use with operating systems
Memory remapping	
Memory remapping Per-slot control	that support more than 4 GB (Windows XP 64-bit edition, Linux) Allows individual slot configuration (option ROM., latency)



Technical Specifications

Pre-boot diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED	
Industry Standard	Revision Supported by the BIOS	
ACPI	Advanced Configuration and Power Management Interface, Version 2.0	
ASF	Alert Standard Format Specification, Version 2.0	
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b	
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0	
BBS	BIOS Boot Specification v1.01	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal	
CD Boot	"El Torrito" Bootable CD-ROM Format Specification Version 1.0	
EDD	Enhanced Disk Drive Specification Version 1.1	
	BIOS Enhanced Disk Drive Specification Version 3.0	
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0	
PCI	PCI Local Bus Specification, Revision 2.3	
	PCI Power Management Specification, Revision 1.1	
	PCI Firmware Specification, Revision 3.0, Draft .7	
PCI Express	PCI Express Base Specification, Revision 1.0a	
PMM	POST Memory Manager Specification, Version 1.01	
SATA	Serial ATA Specification, Revision 1.0a	
	• Serial ATA 3 Gb/s: Extensions to Serial ATA 1.5 Gb/s, Revision 1.0	
SAS	SAS specification 1.1	
Smbios	System Management BIOS Reference Specification, Version 2.4	
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B	
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1	
USB 1.1	Universal Serial Bus Revision 1.1 Specification	
USB 2.0	Universal Serial Bus Revision 2.0 Specification	

Other deployment & management features

HP Client Management Solutions (Windows XP	HP Client Management Solutions help simplify management of Workstations and significantly reduce total ownership costs. These solutions share a common design and are highly integrated.	
only)	 HP Client Manager Software is included free with all HP business PCs and Workstations. It enable central tracking, monitoring, and management of the hardware aspects of HP client systems: Get valuable hardware information such as CPU, memory, video, and security settings Monitor system health to fix problems before they occur Install drivers and BIOS updates without visiting each PC Remotely configure BIOS and security settings Automate processes to quickly resolve hardware problems 	
	 Additional solutions (fee-based) are available to address Workstation management challenges through the entire IT lifecycle including: Inventory assessment Software license compliance Personality migration Software image deployment Software distribution Asset management Client backup and recovery 	



	Problem resolution	
	Visit <u>http://www.hp.com/qo/clientmanager</u> for more information, to download HP Client Manager	
	Software.	
HP ProtectTools	HP ProtectTools Security Manager can be configured to prevent unauthorized access using Smart	
(Windows XP only)	Cards, TPM Embedded security chips, USB tokens and other security technologies. HP ProtectTools	
	Security Manager is completely customizable, which gives customers the flexibility to choose the level	
	of security that best meets their needs.	
	Smart Card security for HP ProtectTools	
	 Initialization and configuration of the Smart Card 	
	 Manage Smart Card accounts and security settings Embedded Security for HP ProtectTools 	
	 TPM Embedded Security Chip configuration and management 	
	Credential Manager for HP ProtectTools	
	BIOS configuration for HP ProtectTools	
	 BIOS configuration and security settings from within the HP ProtectTools Security Manager console 	
	Visit http://h18004.www1.hp.com/products/security/ for more information on HP ProtectTools.	
System Software Manager	A free utility that detects and updates BIOS, device drivers, and management agent versions on your	
(free - Windows XP only)	networked PCs and workstations	
Replicated setup	Saves BIOS settings to diskette or USB disk-on-key in human readable file. Repset.exe utility can then	
replicate these settings on machines being deployed without entering ROM-based F10 setup		
Software restore CD		
Asset tag	Repository for storing company-specific property asset numbers for easy tracking	
looting	 Initially set equal to the system serial number 	
	 Stored in a protected section of non-volatile memory that can be accessed and modified with 	
	the F10 Setup program	
DIMM serial presence	Detects whether or not memory DIMMs are present and their type	
detect		
	Hard drive manufacturer, model, and serial number is stored in the hard drive firmware and reported ir	
model, and manufacturer		
Memory Change Alert (Requires HP Client	Alerts management console if memory is removed or changed	
Manager Software –		
Windows XP only)		
, · · · · · · · · · · · · · · · · · · ·	A uses defined atriag starsed in personalitie memory that is aligned at in the DIOC sector.	
Ownership tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen	
Protocol-level Integrity	A feature of SATA and SAS, Cyclic Redundancy Checking provides command, data and message	
Monitoring	transfer verification and proactive notification of problems with recommendations for enhancing system	
Monitoring (CRC checking)	performance. It detects all the following errors' types:	
5	performance. It detects all the following errors' types:single bit errors	
5	 performance. It detects all the following errors' types: single bit errors double bit errors 	
5	 performance. It detects all the following errors' types: single bit errors double bit errors an odd number of errors 	
(CRC checking)	 performance. It detects all the following errors' types: single bit errors double bit errors an odd number of errors error bursts up to 32-bits long 	
5	 performance. It detects all the following errors' types: single bit errors double bit errors an odd number of errors 	



	 hard drive for physical faults and then reports any faults to the user. Running independently of the operating system, it can be accessed through the computer's 	
	setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced.	
	The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures. DPS Access through F10 Setup during Boot (F10 diagnostic access not available with SCSI drives)	
SMART technology (Self-monitoring, analysis and reporting technology	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re- allocated sector count, spin retry count, calibration retry count.	
– Windows XP only)	By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure.	
	SMART I – Drive Failure Prediction	
	SMART II – Off-Line Data Collection	
	SMART III – Off-Line Read Scanning with Defect Reallocation	
Serviceability Features of System		
, Access panel	Tool-less, one-handed	
Optical drives	Tool-less	
Floppy drive	Tool-less	
Hard drives	Tool-less	
Expansion cards	Tool-less	
Chassis fan removal	Tool-less	
Green user touch points	Yes, on tool-free internal chassis mechanisms	
Color-coordinated cables	Yes	
and connectors		
Memory	Tool-less	
CPUs	Requires T15 Torx driver, can be upgraded without removing any internal components except processor heat sink.	
Power supply diagnostic LED	Yes, dual function: AC OK & power OK	
Power button	Yes, ACPI multi-function	
Power LED	Yes, dual color LED indicates normal operation and faults.	
Hard drive activity LED	Yes	
Internal speaker	Yes, used for pre-boot diagnostic beep codes	
Dual color power and HD	green – normal	
LED on front panel	red – fault	
(Indicates normal		
Operations and fault		
Conditions)		
	Recovers corrupted system BIOS.	
flash recovery with video		
	l Vac	
Configuration record SW	Yes	
Over-temp warning on screen (Requires IM	Yes	
Percen (keyones livi	<u> </u>	



Technical Specifications

Agents)	
OS CD (Restore OS CD)	Restores computer to its original factory shipping image; No recovery CDs will ship with Linux – an ISO image will be available on an HD partition.
Restore CD	Restores the computer to its original factory shipping image
Flash ROM	Yes
3.3V Aux Power LED on system PCA	No
Dual Function 5V Aux Power LED (ON)/PS_ON LED (OFF) on system PCA	No
Diagnostic power switch LED on board	No
Clear password jumper	Yes
Clear CMOS button	Yes
easy replacement	Yes
Processor ZIF Socket for easy upgrade	Yes
DIMM connectors for easy upgrade	Yes
NIC LEDs (integrated) (Green & Amber)	Used to determine NIC status
ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments
Dual function front power switch	Also acts as a reset switch when held for 4 seconds
Service and Support	On-site Warranty and Service (Note 1): This three-year, limited warranty and service offering delivers three years of on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am – 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering.
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
	NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US Energy Star (Not in Linux)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- IT ECO declaration
- Japan PC Green label*

*NOTE: This product conforms to the examination standards (2003 version) under JEITA's 'PC Green



Technical Specifications

Label System.'

Energy Consumption and noise emissions

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Convertible Mini tower Desktop model is based on a "Typically Configured Desktop"

Processor Info	2x2 GHz
Memory Info	4x1 GB 667 MHz
Graphics Info	FX 1500
Disks/Optical/Floppy	2x 80 GB SATA / 1 Optical / 1 Floppy

Energy Consumption

	115 VAC		230 VAC		100	VAC
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (SO)	180) W	176	5 W	180) W
Windows Busy (SO)	205	δW	200) W	203	3 W
Sleep (S3)	4.1 W	4.3 W	4.8 W	4.1 W	4.3 W	4.8 W
Off (S5)	2.4 W	2.0 W	3.0 W	2.4 W	2.0 W	3.0 W

Heat Dissipation**

	115 VAC		230 VAC		100	VAC
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (SO)	614 B	STU/hr	501 E	TU/hr	614 B	TU/hr
Windows Busy (SO)	700 E	STU/hr	683 E	TU/hr	691 B	TU/hr
Sleep (S3)	14 BTU/hr	15 BTU/hr	16 BTU/hr	14 BTU/hr	15 BTU/hr	16 BTU/hr
Off (S5)	8.2 BTU/hr	6.8 BTU/hr	10 BTU/hr	8.2 BTU/hr	6.8 BTU/hr	10 BTU/hr

NOTES:

* Energy Star low energy mode

** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (in accordance with ISO 7779 and ISO		Sound Power (LWad, bels)	Deskside Sound Pressure (LpAm, decibels)
9296)	Idle	TBD	TBD
	Fixed Disk	TBD	TBD
	(random writes)		
	Optical Drive	TBD	TBD-
	(sequential reads)		

Longevity and Upgrading

g This product is designed to be upgraded, possibly extending its useful life by several years. Spare parts are available throughout the warranty period and for up to 5 years after the end of production. Upgradeability features contained in the product include:

- Intel LGA775 processor socket
- 8 USB ports
- 2 PCI slots and 4 PCI Express slots
- 5 storage bays
- 4 memory slots



Additional Information This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2002/95/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO 1043. This product contains 0% recycled materials (by wt.) This product contains 0% recycle-able when properly disposed of at end of life. Packaging Materials External Cardboard carton and 2.70 kg insert Internal LDPE Foam 0.35 kg Material Usage This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specifications for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supple/tain/gen_specifications.html): Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chorinated Hydrocarbons Chorinated Hydrocarbons Lead carbonales and sulfates Lead carbonales and sulfates Lead carbonales and sulfates Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl (PCB) Polybrominated Biphenyl (PCB) Polybrominated Biphenyl (PCB)	Batteries	 EU Directive EU Directive EU Directive EU Directive Batteries used in the Mercury gree Cadmium g 	es with ISO standards: 91/157/EEC 93/86/EEC 98/101/EEC product do not contain: eater the 5ppm by weight reater than 10ppm by weight r than 4000ppm by weight. 2 (coin cell)				
Internal LDPE Foam 0.35 kg Material Usage This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/ supplychain/gen_specifications.html): Asbestos Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocardons Chlorinated Paraffins Formaldehyde Halogenated Diphenyl Methanes Lead and Lead compounds Marcuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl S(PBBS) Polybrominated Biphenyl P(CB) Polychorinated Biphenyl P(CB) Polychorinated Biphenyl P(CB) Polychorinated Biphenyl P(CT) Polychorinated Eiphenyl (P(CT)	Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2002/95/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. This product contains 0% recycled materials (by wt.) This product is >90% recycle-able when properly disposed of at end of life. 					
Internal LDPE Foam 0.35 kg Material Usage This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html): • Asbestos • Certain Azo Colorants • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics • Cadmium • Chlorinated Paraffins • Chlorinated Paraffins • Formaldehyde • Lead and Lead compounds • Material Biphenyl Methanes • Lead and Lead compounds • Meterial Biphenyl Methanes • Lead and Lead compounds • Mercuric Oxide Batteries • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. • Ozone Depleting Substances • Polybrominated Biphenyl (PCB) • Polybrominated Biphenyl (PCB) • Polybrominated Biphenyl (PCB) • Polychlorinated Biphenyl (PCC) • Polychlorinated Biphenyl (PCC)		External		2.70 kg			
 HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/ supplychain/gen_specifications.html): Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead carbonates and sulfates Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl Ethers (PBBs) Polybrominated Biphenyl Ethers (PBBCs) Polybrominated Biphenyl (PCT) Polychlorinated Biphenyl (PCT) Polychlorinated Biphenyl (PCT) 		Internal		0.35 kg			
 Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) 	Material Usage	HP General Specific Environment at http:// supplychain/gen_sp Asbestos Certain Azc Certain Brow Cadmium Chlorinated Chlorinated Formaldehy Halogenate Lead carbow Lead and Le Mercuric O Nickel – fin or carried b Ozone Dep Polybrominc Polybrominc Polybrominc Polybrominc Polybrominc Polybrominc Polychlorina Polychlorina Polychlorina Polychlorina Polychlorina Polyvinyl Ch been volunt Radioactive Tributyl Tin (ation for the <u>(/www.hp.com/hpinfo/global</u>) <u>ecifications.html</u>): Colorants minated Flame Retardants – may Hydrocarbons Paraffins de d Diphenyl Methanes nates and sulfates ead compounds xide Batteries ishes must not be used on the ex- y the user. leting Substances ted Biphenyls (PBBs) ted Biphenyl Ethers (PBBEs) ted Biphenyl Oxides (PBBOs) ted Biphenyl Oxides (PBBOs) ted Biphenyl (PCB) ted Terphenyls (PCT) noride (PVC) – except for wires of arily removed from most applica Substances TBT), Triphenyl Tin (TPT), Tributyl	citizenship/environment/ y not be used as flame retardants in plastics aternal surface designed to be frequently handled and cables, and certain retail packaging has tions.			
Packaging HP follows these guidelines to decrease the environmental impact of product packaging:	Packaging	HP follows these gui	delines to decrease the environn	nental impact of product packaging:			



	 Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <u>http://www.hp.com/recycle</u> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: [link to new HP white paper now in progress] Global Citizenship Report <u>http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html</u> Eco-label certifications <u>http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html</u> ISO 14001 certificates: <u>http://www.hp.com/hpinfo/globalcitizenship/environment/operations/environment.html</u>



Technical Specifications – Audio

High Definition Integrated Realtek ALC262 Audio	Туре	Integrated
	High Definition codec	Yes
	SPDIF	No
	External audio jacks	One front stereo analog microphone-in
		One front stereo headphone-out
		One rear line-in
		One rear line-out
		One rear stereo analog microphone-in
	Internal audio connectors	AUX-IN line-level analog input
	Retasking	NOTE: All external audio ports are retaskable as Line-In, Line-Out, Microphone-In, or Headphone-Out
	Sampling	44.1 kHz/48 kHz/96 kHz/192 kHz (output only)
	Wavetable syntheses (software)	Yes – Uses OS soft wavetable
	Digital audio	Yes
	Analog audio	Yes
	Number of channels on Line-Out (mono/stereo)	Two independent stereo outputs (Left & Right channels)
	Internal audio speaker power rating	1.5 W
	Internal speaker	Yes
	Microphone features	Stereo Microphone supporting: Acoustic echo cancellation Noise suppression Beam forming

SoundBlaster X-Fi XtremeMusic audio card Windows XP Only	Audio Quality	Total Harmonic Distortion + Noise at 1kHz (20kHz Low-pass filter) = 0.004%
	Signal to Noise Ratio (SNR)	Signal-to-Noise Ratio (20kHz Low-pass filter, A-Weighted) Stereo Output: 109dB
		Front and Rear Channels: 109dB
		Center, Subwoofer and Side Channels: 109dB
	Sound Conversion	24-bit Analog-to-Digital conversion of analog inputs at 96kHz sample rate
		24-bit Digital-to-Analog conversion of digital sources at 96kHz to analog 7.1 speaker output
		24-bit Digital-to-Analog conversion of stereo digital sources at 192kHz to stereo output



Technical Specifications – Audio

1000 – AUGIO						
Recording/ Sampling Rate	16-bit to 24-bit recording s 32, 44.1, 48 and 96 kH:	sampling rates: 8, 11.025, 16, 22.05, 24, z				
ASIO 2.0 support	16-bit/44.1kHz, 16-bit/4 24-bit/96kHz with direct	18kHz, 24-bit/44.1kHz 24-bit/48kHz and monitoring				
Enhanced SoundFont support	Up to 24-bit resolution					
	24-bit/96kHz					
DACs	24-bit/192kHz					
Voice Support	128 voices					
Max. Channels in 3D Positional Audio	7.1					
EAX® ADVANCED HD™ 5.0 support	Yes including EAX® Macro FlexiFX™	pFX™, EAX® PurePath™ and Environment				
Connectors	FlexiJack (Performing a 3-ir via 3.50 mm minijack	n-1 function, Digital In / Line In / Microphone)				
	Line level out (Front / Rear 3.50 mm minijacks	Line level out (Front / Rear / Center / Subwoofer / Rear Center) via				
	AUX_IN line-level analog i	nput via 4-pin Molex connector on card				
	One AD_Link (26 pin) con (upgrade option)	nector for linking to the X-Fi I/O Console				
Dimensions	7.25" x5" x .9" (x x)					
Additional product	Movies	THX Certification				
features		Dolby Digital EX 6.1 Playback				
		DTS-ES 6.1 Playback				
	Music	X-Fi 24-bit Crystalizer				
		CMSS-3D				
		SuperRipÔ				
	Audio Creation	Pristine audio playback quality with a near transparent SRC engine				
		Up to eight 24 bit hardware effects				
		ASIO recording with latency as low as one millisecond				
		24-bit SoundFont® sampling				
		3D MIDI				
Minimum system	System RAM	256MB				
requirements	Hard disk	600MB free space				
		Available PCI 2.1 slot for the audio card				
		CD-ROM/CD-RW or CD/DVD-ROM required for software installation				
	Operating System	Microsoft® Windows® XP Service Pack 2 (SP2)				



Technical Specifications – Peripherals

Integrated Broadcom BCM5752 LAN-on- Motherboard	Connector Controller Memory Data rates supported Compliance Bus architecture Data transfer mode Hardware certifications	RJ-45 Intel 82540EM Gigabit Controller Integrated 96Kb frame buffer memory 10/100/1000 Mbps IEEE 802.1A, 802.1P, 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control PCI 2.2 Bus-master DMA FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union
	Power requirement	1.48 watts @ +3.3V AUX supply with 5V tolerance
	Boot ROM support	Yes
	Network transfer rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T, 1000 Mbps
	Operating system driver support	Microsoft Windows XP, Red Hat Enterprise Linux WS 3, Red Hat Enterprise Linux WS 4
	••	ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Intel PROset II utility
Broadcom BCM5751	Connector	RJ-45
NetXtreme Gigabit	Controller	Broadcom 5751 PCIE 1.0a LAN Controller
Ethernet Controller (PCIe)	Memory	Integrated 96Kb frame buffer memory
	Data rates supported	10/100/1000 Mbps
	Compliance	IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control
	Bus architecture	PCle 1.0a
	Data path width	X1
	Data path speed	2.5Gbit per sec per direction transfer rate
	Data transfer mode	Bus-master DMA
	Hardware certifications	FCC class B, NRTL Mark Canada and United States, C-Tick for Australia, BSMI for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia
	Power requirement	3.1 watts @ +3.3V AUX supply
	Boot ROM support	Yes
	Network transfer rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T, 1000 Mbps



Technical Specifications – Peripherals

		Environmental Dimensions Operating system drive support Management capabili Alerting Kit contents	Enterprise Linux WS 4 ties WOL, PXE , Remote cab ASF 2.0	85% at 131° F (55 1.2 x 5.5 x .2 cm) Red Hat Enterprise Linu ple management Broadcom NetXtreme C	5° C) ux WS 3, Red Hat Gigabit Ethernet PCI NIC,
SATA 3Gb/s hard drives	80 GB	Height Width Interface Synchronou	Height Width Interface Synchronous Transfer Rate (Maximum)		b bytes less 3.5 in (8.89 cm) (10.2 cm) b/s)
			cks	8 MB Single Track Average Full-Stroke 7,200 rpm 156,301,488 41° to 131° F (5°	0.9 ms 11.0 ms 18 ms to 55° C)
	160 G	Height Width Interface Synchronou Cache	Capacity Height Width Interface Synchronous Transfer Rate (Maximum)		26 bytes 3.5 in (8.89 cm) (10.2 cm) b/s), Native Command
	250 G	controller o Rotational S Logical Blo Operating	•	Single Track Average Full-Stroke 7,200 rpm 312,581,808 41° to 131° F (5° 250,059,350,01	



Technical Specifications – Peripherals

Technical Spi	ecincunons -	renprieruis			
		Height	1 in (2.54 cm)		
		Width	Media diameter: 3.5 i	n (8.89 cm)	
			Physical size: 4 in (10.	2 cm)	
		Interface	Serial ATA (3.0 Gb/s) Queuing enabled	, Native Command	
		Synchronous Transfer Rate (Maximum)	300 MB/s		
		Cache	16 MB		
		Seek Time (typical reads, includes	Single Track	1.0 ms	
		controller overhead, including settling)	Average	11.0 ms	
			Full-Stroke	18 ms	
		Rotational Speed	7,200 rpm		
		Logical Blocks	488,397,168		
		Operating Temperature	41° to 131° F (5° to 5	5° C)	
		- F	V	7	
	500 GB	Capacity	500,107,862,016 by	/tes	
		Height	1 in (2.54 cm)		
		Width	Media diameter: 3.5 in (8.89 cm)		
			Physical size: 4 in (10.		
		Interface	Serial ATA (3.0 Gb/s), Native Comman Queuing enabled		
		Synchronous Transfer Rate (Maximum)	300 MB/s		
		Cache	16 MB		
		Seek Time (typical reads, includes	Single Track	1.3 ms	
		controller overhead, including settling)	Average	20.0 ms	
			Full-Stroke	30 ms	
		Rotational Speed	7,200 rpm		
		Logical Blocks	976,773,168		
		Operating Temperature	41° to 131° F (5° to 5	5° C)	
Serial Attached SCSI (SAS) hard	146 GB (10K rpm)	Capacity	146,815,737,856 bytes		
drives		Height	1.0 in (25.4mm)		
		Width	4.0 in (101.6mm)		
		Interface	SAS		
		Synchronous Transfer Rate (Maximum)	3.0 Gb/s		
		Buffer	8 MB		
		Seek time	Single track	.3 ms	
		(typical reads, including settling)	Average	<4.5 ms	
			Full-stroke	<11.0 ms	
		Rotational Speed	10,000 rpm		
		Logical Blocks	286,749,488 - 512	byte blocks	



Technical Specifications – Peripherals

7	7				
	Operating Te	mperature	50° to 95° F (10° to	35° C)	
72 GB	1 /		73,407,856,856		
(15К гр	om)		bytes		
	Height		1.0 in (25.4mm)		
	Wid t h		4.0 in (101.6mm)		
	Interface		SAS		
	Synchronous	Transfer Rate (Maximum)	3.0 Gb/s		
	Buffer		8 MB		
	Seek Time		Single Track	0.27 ms	
	(typical reads,	, including settling)	Average	3.5 ms	
			Full-Stroke	7.4 ms	
			Rotational Speed	1 <i>5,</i> 000 rpm	
	Rotational Spe	eed	1 <i>5,</i> 000 rpm		
	Logical Blocks	3	143,374,738 – 512 byte blocks		
	Operating Ter	mperature	50° to 95° F (10° to 35° C)		
146 G (15K rp	· · · ·		146,815,737,856 bytes		
	Height		1.0 in (25.4mm)		
	Width		4.0 in (101.6mm)		
	Interface		SAS		
	Synchronous ⁻	Fransfer Rate (Maximum)	3.0 Gb/s		
	Buffer		8 Mbytes		
	Seek Time		Single Track	0.27 ms	
	(typical reads,	, including settling)	Average	3.5 ms	
			Full-Stroke	7.4 ms	
			Rotational Speed	1 <i>5,</i> 000 rpm	
	Rotational Spe	eed	1 <i>5,</i> 000 rpm		
	Logical Blocks	5	286,749,488 - 512	2 byte blocks	
	Operating Ter	mperature	50° to 95° F (10° to	35° C)	
HP IEEE 1394aFireWire	Device Interface Protocol	IEEE-1394a			
4-Port PCI Card	Host Bus Burst Data Rate				
(Windows XP Only)					
, .	Devices Supported	IEEE-1394 compliant devi	ces		
	Bus Interface	PCI			
	Physical	PCI card with brackets for	low profile and full heig	ght PCI slots.	
	Environmental	Operating temperature 50° to 131° F (10° to 55° C)		to 55° C)	
		Non-operating temperature	e -22° to 140° F (-30°	° to 60° C)	
			``	,	



Technical Specifications – Peripherals

	Relative humidity	20% to 80%	
Ports	Two IEEE1394 6-Pin Connector (Rear)		
Connectors	One 10-Pin (9 Contacts) Custom Connector (Internal)		
Minimum System Requirements	Microsoft Windows XP Professional, Windows XP Home, not supported or Linux		
	Pentium II 266 or abov	/e	
	128-MB RAM		
	1-GB Hard Drive		
	CD-ROM drive		
	Built-in sound system		
	Available PCI slot		
Regulatory Agency Approval	,	50950, CE Mark EN55022B(1995)/EN55024- 5MI CNS13438, Korea MIC	

HP IEEE 1394b FireWire	Device Interface Protocol	IEEE-1 394a	
4-Port PCI Card (Windows XP Only)	Host Bus Burst Data Rate	400 Mbps	
	Devices Supported	IEEE-1394 compliant device	25
	Bus Interface	PCI	
	Physical	PCI card with brackets for low profile and full height PCI slots.	
	Environmental	Operating temperature	50° to 131° F (10° to 55° C)
		Non-operating temperature	-22° to 140° F (-30° to 60° C)
		Relative humidity	20% to 80%
	Ports	Two IEEE1394 6-Pin Connector (Rear)	
	Connectors	One 10-Pin (9 Contacts) Custom Connector (Internal)	
	Minimum System Requirements	Microsoft Windows XP Professional, Windows XP Home, not su Linux	
		Pentium II 266 or above	
		128-MB RAM	
		1-GB Hard Drive	
		CD-ROM drive	
		Built-in sound system	
		Available PCI slot	
	Regulatory Agency Approval	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN5502 1998 STD, Taiwan BSMI CNS13438, Korea MIC	

USB 2.0 Disk on Key

Dimensions (HxWxD)

xD) 0.9 x 0.7 x 3.9 in (2.3 x 1.8 x 9.8 cm)



Technical Specifications – Peripherals

	Weight USB Specification Transfer Rate Storage Media Power Supply Capacity	0.05 lb (0.02 kg) 2.0 Read-1023 KB/Sec; Write-850 KB/Sec Solid state flash memory, no moving parts USB Bus-powered, no external power required 512 MB or 1 GB	
HP StorCase Removable Enclosure	Physical characteristics	Dimensions of carrier $(H \times W \times D)$	1.07 x 4.34 x 7.54 inches (27.2 x 110.2 x 191.5 mm)
		Weight of carrier	1 lbs (0.45 kg)
		Dimensions of receiving frame $(H \times W \times D)$	1.62 x 5.75 x 7.88 inches (41.1 x 146.1 x 200.2 mm)
		Weight of receiving frame	N/A
		Dimensions of receiving frame - including front bezel $(H \times W \times D)$	1.62 x 5.81 x 8.08 inches (41.1 x 147.6 x 205.2 mm)
		Weight of receiving frame - including front bezel	2 lbs (0.91 kg) (1)
		Features	Allows you to mount a low-profile (up to 1 inch high) 3.5 inch form factor drive into any half-height, 5.25 inch peripheral bay
			Supports Serial Attached SCSI (SAS) or Serial ATA 3 Gb/s drives
			 Drive carrier key lock Drive spin/power up/down button Power, spin, and fan failure indicator Drive activity indicator Soft Start circuitry & anti-static device protection Cable-less drive connector 50K mating connector Cooling fan
	Electrical	Input	+5V 9mA / +12V 20 μA
	Chassis reliability/	MTBF (at 30° F)	600,000 hours
	maintainability	MTTR	5 minutes
	Environmental	Operating ambient temperature	0° to 50° C
		Storage ambient temperature	-40° to 70° C
		Operating relative humidity (2)	5% to 95% 1000 to 10,000 ft
		Storage relative humidity (2)	50% to 95% -1000 to 40,000 ft



Technical Specific	ations – Peripherals		
		Operating altitude	-305m to 3048m
		Storage altitude	-305m to 12195m
		Operating shock (3)	60g
		Storage shock (3)	30
		 With carrier remove Non-condensing w Half-sine wave sho 	ith maximum gradient of 10% per hour
PS/2 OR USB '04 Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
		Dimensions (L \times W \times H)	$18.0 \times 6.4 \times 0.98$ in (45.8 × 16.3 × 2.5 cm)
		Weight	2 lb (0.9 kg) minimum
	Electrical	Operating voltage	+ 5VDC ± 5%
		Power consumption	50-mA maximum (with three LEDs ON)
		ESD	CE level 4, 15-kV air discharge
		EMI - RFI	Conforms to FCC rules for a Class B computing device
		MicrosoftPC 99 - 2001	Functionally compliant
	Mechanical	Languages	38 available
		Keycaps	Low-profile design
		Switch actuation	55-g nominal peak force with tactile feedback
		Switch life	20 million keystrokes (using Hasco modifie tester)
		Switch type	Contamination-resistant switch membrane
		Key-leveling mechanisms	For all double-wide and greater-length keys
		Cable length	6 ft (1.8 m)
		Microsoft PC 99 - 2001	Mechanically compliant
		Acoustics	43-dBA maximum sound pressure level
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)
		Non-operating temperature	-22° to 140° F (-30° to 60° C)
		Operating humidity	10% to 90% (non-condensing at ambient)
		Non-operating humidity	20% to 80% (non-condensing at ambient)
		Operating shock	40 g, six surfaces
		Non-operating shock	80 g, six surfaces
		Operating vibration	2-g peak acceleration
		Non-operating vibration	4-g peak acceleration
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequenc
		Drop (in box)	42 in (107 cm) on concrete, 16-drop



Technical Specificat	ions – Peripherals			
	Approvals	Microsoft XP Professional, and XP Professional x64 Edition, Red Hat Enterprise Linux WS 3, Red Hat Enterprise Linux WS 4 UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC ANSI HFS 100, ISO 9241-4, and TUVGS Keyboard, keyboard software media, installation guide, warranty card, safety and comfort		
	Ergonomic compliance Kit contents			
HP 2-Button Scroll Mouse (PS/2)	Maximum Rotation Speed Switch Type	8 mm 30 mm/s Light force micro-switch		
	Switch Life			
	Mechanical Life Environmental	Minimum 200,000 revolutio		
	Environmental Mechanical Regulatory Approvals	Operating Humidity Non-operating Humidity Operating Shock Non-operating Shock Operating Vibration Non-operating Vibration Resolution Tracking Speed Acceleration Switch Actuation Switch Life Cable Length PC98-99	50° to 122° F (10° to 50° C) -22° to 140° F (-30° to 60° C) 10% to 90% (non condensing at ambient) 20% to 80% (non condensing at ambient) 40 g, 6 surfaces 80 g, 6 surfaces 2 g peak acceleration 4 g peak acceleration 400 ± 20% DPI 10 in/s maximum 100 in/s 85 g nominal peak force 1,000,000 operations (using Hasco modified tester) 2 m Mechanically compliant UV, TUV GS, VCCI, BCIQ, C-Tick	
HP 2-button Optical Scroll Mouse (USB)	Dimensions $(H \times L \times W)$ Weight Cable length System requirements	1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm) 0.27 lb (0.12 kg) 72.8 in (185 cm) Microsoft Windows XP, Red Hat Enterprise Linux WS 3, Red Hat Enterprise Linux WS 4		
HP Optical 3-Button Mouse (USB)	Dimensions/Weight	Height Length	1.5 in (3.6 cm) 4.5 in (11.56 cm)	



Technical Specifications – Peripherals

/			
		Width	2.2 in (6.19 cm)
		Weight	3.80 oz (108 g)
Er	nvironmental	Operating temperature	32° to 104° F (0° to 40° C)
		Non-operating temperature	-4° to 140° F (-20° to 60° C)
		Operating humidity	10% to 90% (non condensing at ambient)
Μ	lechanical	Tracking speed	6 in/s Maximum
		Switch life	3,000,000 operations
		Switch type	Micro-switches
		Tracking mechanism life	155 miles (250 km) at average speed of 10 in/s
		Cable length	6 ft (1.8 m)
ceball 5000 (USB - Ph	ysical characteristics	Dimensions $(H \times W \times D)$	3.0 x 6.0 x 8.4 in (7.6 x 15.2 x 21.3 cm)
ndows XP Only)	,	Ball Diameter	2.2 in (5.6 cm)
		Weight	2.1 lb (9.94 kg)
		Features	Six degrees of freedom motion control throug the X, Y, Z axis (pitch, roll, yaw) Certified for leading CAD and DCC applications
En	vironmental	Operating temperature	50° to 104° F (10° to 40° C)
		Non-operating temperature	43° to 140° F (6° to 60° C)
		Operating humidity	8% to 80% (non-condensing at ambient)
		Non-operating humidity	5% to 80% (non-condensing at ambient)
M	echanical	Buttons	12 programmable (unshifted)
		Ball Force Range	0.5 - 8.2N/1.8 - 29.5 oz
		Ball Torque Range	0.085 – 0.33 oz-in. (6.91 Nmm)
		Resolution	10 bits
Se	erial Specifications	Connector	USB 1.1 or greater
		Cable Length	12.8 ft. (3.9 m)
		Data Rate	USB model – 16 msec
		Flow Control	Xon/Xoff (on PS/2 model only)
Sc	oftware Drivers Available	USB model	Microsoft Windows XP, not supported in Linu:
Sy	stem Requirements	Disk Space	10 MB free disk space
Re	gulatory Approvals		50, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick
	ysical characteristics		

 HP SpaceMouse Plus (USB - Windows XP Only)
 Physical characteristics
 Dimensions (H × W × D)
 7.4 × 4.72 × 1.73 in (18.8 × 12.0 × 4.4 cm)

 Cap Diameter
 2 × 6.5 × 6.6 mm



Technical Specifications – Peripherals
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		Weight	1.5 lb (0.68 kg)
		Features	Six degrees of freedom motion control through the X, Y, Z axis (pitch, roll, yaw) Certified for leading CAD and DCC applications
	Environmental	Operating temperature	41° to 140° F (5° to 60° C)
		Non-operating temperature	, ,
		Operating humidity	10 to 98 % RH (non-condensing)
		Non-operating humidity	10 to 98 % RH (non-condensing)
	Mechanical	Buttons	11 programmable (unshifted)
		Cap Force Range	0.2 N – 4.5 N
		Cap Torque Range	4 Nmm to 100 Nmm
		Resolution	8 bit
	USB Specifications	Connector	USB 1.1 or greater
		Cable Length	2 m
		Data Rate	16 msec
	Software Drivers Availab	le Microsoft Windows XP, not	t available in Linux
	System Requirements	Disk Space	10 MB free disk space
		•	
	Regulatory Approvals	UL, cUL, EN 950, EN 609	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick
•		UL, cUL, EN 950, EN 609	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN
•	Regulatory Approvals	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick
•	Regulatory Approvals	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions (L x W x H)	950, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3″ x 5.6″ x 2.0″ (236 x 143 x 53mm)
•	Regulatory Approvals	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions $(L \times W \times H)$ Weight	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg)
•	Regulatory Approvals Physical characteristics	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions $(L \times W \times H)$ Weight Palmrest	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg) Sculpted 21+ programmable speed keys
HP SpacePilot (USB – Windows XP Only)	Regulatory Approvals Physical characteristics	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions $(L \times W \times H)$ Weight Palmrest Buttons LCD Viewing Area Active Area	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg) Sculpted 21+ programmable speed keys 15 reprogrammable
	Regulatory Approvals Physical characteristics	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions (L × W × H) Weight Palmrest Buttons LCD Viewing Area Active Area Display Format	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg) Sculpted 21+ programmable speed keys 15 reprogrammable (W x H) 4.0" x 1.0" (102.4 x 30.2mm) (W x H) 3.7" x 1.0" (93.4 x 26.2mm) 240x64
	Regulatory Approvals Physical characteristics	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions $(L \times W \times H)$ Weight Palmrest Buttons LCD Viewing Area Active Area	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg) Sculpted 21+ programmable speed keys 15 reprogrammable (W x H) 4.0" x 1.0" (102.4 x 30.2mm) (W x H) 3.7" x 1.0" (93.4 x 26.2mm)
•	Regulatory Approvals Physical characteristics	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions (L × W × H) Weight Palmrest Buttons LCD Viewing Area Active Area Display Format	 250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg) Sculpted 21+ programmable speed keys 15 reprogrammable (W x H) 4.0" x 1.0" (102.4 x 30.2mm) (W x H) 3.7" x 1.0" (93.4 x 26.2mm) 240x64 Six degrees of freedom motion control through
•	Regulatory Approvals Physical characteristics	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions $(L \times W \times H)$ Weight Palmrest Buttons LCD Viewing Area Active Area Display Format Motion Controller	250, CSA, FCC, CE Mark, TUV, CISPR 22, EN C 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg) Sculpted 21+ programmable speed keys 15 reprogrammable (W x H) 4.0" x 1.0" (102.4 x 30.2mm) (W x H) 3.7" x 1.0" (93.4 x 26.2mm) 240x64 Six degrees of freedom motion control through the X, Y, Z axis (pitch, roll, yaw)
•	Regulatory Approvals Physical characteristics Mechanical	UL, cUL, EN 950, EN 609 50082, IEC 1000 4-2, IEC Dimensions (L × W × H) Weight Palmrest Buttons LCD Viewing Area Active Area Display Format Motion Controller Device Sensitivity	 250, CSA, FCC, CE Mark, TUV, CISPR 22, ENC 1000-4-3, AS/NZS, VCCI, BSMI, C-Tick 9.3" x 5.6" x 2.0" (236 x 143 x 53mm) 1.875 lb (0.85 kg) Sculpted 21+ programmable speed keys 15 reprogrammable (W x H) 4.0" x 1.0" (102.4 x 30.2mm) (W x H) 3.7" x 1.0" (93.4 x 26.2mm) 240x64 Six degrees of freedom motion control through the X, Y, Z axis (pitch, roll, yaw) Adjustable to preference



invent

Capacity

700 MB CD disc

Page 35

Technical Specifications – Peripherals

	Dimensions (HxWxD)	1.63 x 5.83 x 7.27 in (4.13 x 14.6 x 18.5 cm)			
	Weight	1.76 lb (0.8 kg)			
	Interface	ATAPI/EIDE			
	Mounting Orientation	Horizontal or vertical			
	Data Transfer Rates - Reac		d Digital audio extraction (minimum) – 1,200 KB/s (8X) CD read – up to 7,200 KB/s (48X)		
	Media and Formats - Read		Mode 1 and 2), CD-XA Ready, Photo CD 1ixed Mode (Audio and Data combined), CD-1 -RW		
	Data Transfer Modes		Multi-word DMA mode 2 (16.6 MB/s); \B/s); UltraDMA Mode 2 (33.3 MB/s)		
	Access Times (typical)	Random	< 75 ms @ 48x		
		Full-Stroke	< 150 ms		
	Start-up Time (typical)	< 7 s (single session)	< 30 s (multisession)		
	Stop Time (typical)	< 4 s			
	Read Buffer size	128 KB (minimum)			
	Audio Output	Line-Out	0.7 VRMS		
		Signal-to-Noise Ratio	80 dB		
		Channel Separation	65 dB		
	Configuration Jumper Block	Master, slave, and cable se	lect modes		
	Operating Conditions	Temperature	41° to 122° F (5° to 50° C)		
		Humidity	10% to 80%		
	Approvals/ Environmental	UL 1950 (US and Canada), TICK	, CSA, SEMKO, TUV; CE, FDA, FCC, IC, C-		
	Operating Systems Supported		nd XP Professional x64 Edition, 5 3, Red Hat Enterprise Linux WS 4		
	Supplied Software	None			
16X/40X DVD-ROM Drive with +R Read	Height	5.25-in, half-height, tray load			
Support	Interface Type	ATAPI/EIDE			
Support	Dimensions ($W \times H \times D$)	5.88 x 1.71 x 7.87 [max] in (149.5 x 43.25 x 200.0 [max] mm) (external, excluding bezel)			
	Disc Formats	DVD-ROM (single and dual layer); DVD-video; DVD-R version 1.0 and 2.0; DVD-RW version 1.0 and 1.1; DVD-R multi-border; DVD+RW; DVD+R ; CD-ROM Mode 1 and 2; CD-DA; CD-ROM XA Mode 2, Form 1 and 2; CD-extra; CD-text; CD-I Mode 2, Form 1 and 2; CD-I ready; video CD, CD-bridge; PhotoCD (single and multi-session); CD-R; CD-RW			



Technical Specifications – Peripherals			
Disc Capacity	DVD-ROM	4.7 GB (DVD-5), 8.54 GB (DVD-9), 9.4 GB (DVD-10), 3.95 GB (DVD-R version 1.0), 4.7 GB (DVD-R version 2.0), 4.7 GB (DVD-RW version 1.0 and 1.1), 4.7 GB (DVD+RW), 4.7G (DVD+R)	
	CD-ROM	540 MB (Mode 1, 12 cm), 640 MB (Mode 2, 12 cm), 700 MB (80 minimum CD-R and CD-RW), 180 MB (8 cm)	
Access Times	DVD-ROM Single Layer	120 ms	
(typical reads, including	CD-ROM Mode 1	90 ms	
settling)	Full Stroke DVD	240 ms (seek)	
	Full Stroke CD	160 ms (seek)	
	Startup Time	< 10 seconds (typical)	
	Stop Time	< 4 seconds	
	Data Transfer Modes	PIO Mode 4 (16.6 MB/s); Multi-word DMA mode 2 (16.6 MB/s); UltraDMA Mode 3 (44.4 MB/s)	
Maximum Data Transfer	CD-ROM Read	6000 KB/s (40X) Max	
Rates	DVD-ROM Read	21,600 KB/s (16X) Max	
	Digital Audio Extraction	6000 KB/s (40X) Max	
Power	Source	Four-pin, DC power receptacle	
	DC Power Requirement	5 VDC \pm 5% – 100 mV ripple p-p	
		12 VDC ± 5% – 200 mV ripple p-p	
	DC Current	5 VDC – <800 mA typical, < 1000 mA maximum	
		12 VDC – < 870 mA typical, <1800 mA maximum	
Audio Output	Line-Out	0.7 VRMS	
	Signal-to-Noise Ratio	85 dB	
	Channel Separation	65 dB	
Configuration Jumper Block	Master, slave, and cable se	elect modes	
Data Interface Connector	or 40-pin, shrouded and keyed, flat ribbon		
Operating Environmental	Temperature (operating)	41° to 122° F (5° to 50° C)	
(all conditions non- condensing)	Relative Humidity (operating)	10% to 85%	
	Maximum Wet Bulb Temperature (operating)	86° F (30° C)	
Certifications, Approvals	ACA AS/NZS 3548 class VDE EN60950, EN 5502 1, UL 60950, CSA C22.2	certification, Microsoft WHQL certification, B, CNS 13438, C.I.S.P.R. Pub 22, TUV or 2, EN55024, EMKO EN60950, EN 60825- 60950-2000, CFR 21 part 1040 class 1, Class B, DHHS/FDA, ANSI C63.4-1992	



	Operating Systems Supported Kit Contents	Red Hat Enterprise Linux W	and XP Professional x64 Edition, 'S 3, Red Hat Enterprise Linux WS 4 , Roxio Cineplayer Component software, audio le
48X Combo CD- RW/DVD-ROM	Height Mounting Orientation Interface Type Dimensions (W × H × D)	5.25-inch, half-height, tray-load Either horizontal or vertical ATAPI/EIDE 5.77 x 1.71 x 7.87 [max] in (14.66 x 4.34 x 20.0 [max] cm) (externa excluding bezel)	
	Weight (max) Read Only Disc	2.6 lb (1.2 kg) Formats and Modes	CD-ROM-Mode 1; CD-ROM XA-Mode 2
	Parameters	Supported	(forms 1 and 2); CD-Bridge; CD digital audio; CD Extra; CD-I-Mode 2 (forms 1 and 2) and CD-I-Ready; Photo CD (single and multi-session); video CD; DVD (single- and double-layer); DVD-R; DVD-RW; DVD-RW Multi-Border; DVD+R; DVD+R Multisession , and DVD+RW
		Capacity	180 MB (mode 2, 8 cm); 540 MB (mode 1, 12 cm); 650 MB (mode 2, 12 cm); 700 MB (Mode 2, 12 cm); 4.7 GB (DVD-5); 8.54 GB (DVD-9); 9.4 GB (DVD-10)
		CD-ROM, CD-R, CD-RW read	7200 KB/s (48X) Max
		DVD ROM read	21,632 KB/s (16X) Max
	Writeable Disc	Disc Type	CD-R and CD-RW
	Parameters	Write Methods	Disc at Once, Track at Once, Session at Once, Variable Packet, Fixed Packet
		Format and Modes Supported	CD-ROM (mode 1); CD-ROM XA (mode 2, forms 1 and 2); CD digital audio, CD-I (mode 2, forms 1 and 2); video CD; CD- Bridge; Video CD
		Capacity	180 MB (mode 2, 8 cm); 540 MB (mode 1, 12 cm); 650 MB (mode 2, 12 cm); 700 MB (mode 2, 12 cm)
		CD-R write	7200 KB/s (48X) Max
		CD-RW write	4800 KB/s (32X) Max
	Access Times	Random DVD	< 140 ms (typical)
	(typical reads, including	Random CD	< 125 ms, (typical)
	settling)	Full Stroke DVD	< 250 ms (seek)
		Full Stroke CD	< 210 ms (seek)
		Startup Time (single)	< 7 seconds (typical)
		Startup Time (multi-session)	< 30 seconds (typical)



	Stop Time	< 4 seconds
	Cache Buffer	2 MB (minimum)
	Data Transfer Modes	ATA PIO mode 4 (16.7 MB/s); ATA Multi- word DMA mode 2 (16.7 MB/s); ATA UltraDMA Mode 3 44 Mbytes/s (default)
Power	Source	Four-pin, DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p
	DC Current	5 VDC (< 1000 mA typical, < 1600 mA maximum) 12 VDC (< 600 mA typical, < 1400 mA maximum)
	Total Drive Power (standby mode)	< 2.5 Watt
Audio Output	Line-Out	0.7 VRMS
	Signal-to-Noise Ratio	74 dB
	Channel Separation	65 dB
Configuration Jumper Block	Master, slave, and cable select modes	
Data Interface Connector	40-pin, shrouded and keyed, flat ribbon	
Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
(all conditions non-	Relative humidity	10% to 90%
condensing)	Maximum wet bulb temperature	86° F (30° C)
Certifications, Requirements	MPC-3 compliant, multi-read requirements, ATA Spec X3T9.2, ATAPI Spec SFF-8020, ANSI C63.4-1992, UL 1950, ACA AS/NZS 3548, CB Bulletin No. 96A, CSA C22.2 No. 950-1995, CFR 47 C.I.S.P.R. Pub 22 Class B, DHHS/FDA, EMKO-TSE 07/94, TUV EN60950, EN60825-1, MIC, BSMI-CNS 13438, CE, Microsoft PC2001 certification, Microsoft Logo for Windows XP.	
Operating Systems Supported	Windows XP Professional, and XP Professional x64 Edition, Red Hat Enterprise Linux WS 3, Red Hat Enterprise Linux WS 4	
Option Kit Contents	48X Combo CD-RW/DVD-ROM Drive, Roxio DigitalMedia Plus v7.2, Roxio Cineplayer Component, Dantz Retrospect Express 7.0, audio cable, and installation guide.	
Height	5.25-inch, half-height, tray-l	oad

16X DVD+/-RW
LightScribe drive

Height	5.25-inch, half-height, tray-load
Orientation	Either horizontal or vertical
Interface Type	ATAPI/EIDE
Disc Recording Capacity	8.5 GB DL or 4.7 GB standard
Dimensions (W \times H \times D)	$5.9 \times 1.7 \times 8.0$ in (15.0 × 4.4 × 20.3 cm)
Weight (maximum)	2.6 lb (1.2 kg)



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Write Speed (maximum)	DVD+R	Up to16X
	DVD+RW	Up to 4X
	DVD+R DL	Up to 2.4X
	DVD-R	Up to 8X
	DVD-RW	Up to 4X
	CD-R	Up to 40X
	CD-RW	Up to 24X
Read Speed (maximum)	DVD+R/-R/+RW/ -RW/+R DL	Up to 8X
	DVD-ROM	Up to 16X
	CD-ROM, CD-R	Up to 40X
	CD-RW	Up to 32X
Access Time (typical reads, including settling)	Random	DVD: < 130 ms (typical), CD: < 120 ms (typical)
	Full Stroke	DVD: < 240 ms (seek), CD: < 200 ms (seek)
	Startup Time	Single-session: < 15 seconds (typical), Multi- session: < 30 seconds (typical)
	Stop Time	< 4 seconds
	Cache Buffer	2 MB (minimum)
	Data Transfer Modes	ATA PIO mode 4 (16.7 MB/s); ATA Multi- word DMA mode 2 (16.7 MB/s); ATA UltraDMA Mode 3 (44.4 MB/s -default)
Power	Source	Four-pin, DC power receptacle
	DC Power Requirement	5 VDC \pm 5%-100 mV ripple p-p
	·	12 VDC ± 10%-200 mV ripple p-p
	DC Current	5 VDC (< 2000 mA typical, < 2500 mA maximum)
		12 VDC (< 700 mA typical, < 2000 mA maximum)
	Total Drive Power (standby mode)	< 2.5 Watt
Audio Output	Line-Out	0.7 VRMS
	Signal-to-Noise Ratio	74 dB
	Channel Separation	65 dB
Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
(all conditions non-	Relative humidity	10% to 90%
condensing)	Maximum wet bulb temperature	86° F (30° C)
System Configuration	MB recommended 2-D or	r later with 128 MB of memory (required); 256 3-D graphics cards on primary disk drive for lication software; second disk drive for audio



Technical Specifications – Peripherals

	Operating Systems Support	Microsoft Windows XP Professional, Windows XP Home, Red Hat Enterprise Linux WS 3, Red Hat Enterprise Linux WS 4 (LightScribe functionality not supported in Linux)
	Regulatory Approvals	MPC-3 compliant, multi-read requirements, ATA Spec X3T9.2, ATAPI Spec T13.1153D, ANSI C63.4-1992, UL 1950, ACA AS/NZS 3548, CB Bulletin No. 96A, CSA C22.2 No. 950-1995, CFR 47 C.I.S.P.R. Pub 22 Class B, DHHS/FDA, EMKO-TSE 07/94, TUV EN60950, EN60825-1, MIC, BSMI-CNS 13438, CE, Microsoft PC2001 certification, Microsoft Logo for Windows XP.
	Option Kit contents	16X DVD+/-RW LightScribe drive, Roxio DigitalMedia Plus v7.2, Roxio MyDVD Component, Roxio Cineplayer Component, Dantz Retrospect Express 7.0, installation guide, and DVD+R media.
NVIDIA Quadro NVS	Form Factor	Low profile, both ATX and low profile brackets included
285, 128 MB Dual	Graphic Controller	Integrated Quadro 285 2D graphics processor unit (GPU)
Head	Bus type	PCIe
	RAMDAC	Dual 350 MHz (integrated)
	Memory	128 MB DDR (64 MB local frame buffer plus 64 MB of shared system memory via TurboCache technology)
		NOTE: The graphics card uses part of the total system memory (RAM) for graphics performance. System memory dedicated to graphics performance is not available for other use by other programs.
	Connector	DVI DMS-59 to dual DVI Y-cable and DMS-59 to dual-VGA Y-cable
	Dimensions	Low-profile, 2.586 x 6.6 in (6.57 x 16.76 cm)
	Controller clock speed	250 MHz
	Color depth	32 bits/pixel max
	Overlay planes	One 16-bit Video overlay plane
	Maximum pixel clock	350 MHz
	Multi-monitor support	Dual analog or digital monitors
	Single DVI Support	Yes
	Dual DVI Support	Yes
	High-definition Video	Full screen, full frame video playback of HDTV and DVD content
	Processor (HDVP)	DVD-ready motion compensation for MPEG-2
		Independent hardware color controls for video overlay
		Hardware color-space conversion (YUV 4:2:2 and 4:2:0)
		IDCT motion compensation
		5-tap horizontal by 3-tap vertical filtering
		8:1 up/down scaling
	Available graphics drivers	Microsoft Windows XP (Provides full native Dual View mode, Span or Big Desktop mode, and Clone mode), Graphics drivers for Red Hat Enterprise Linux WS 3, and Red Hat Enterprise Linux WS 4



Technical Specifications – Peripherals

HP qualified drivers may be preloaded or available from the HP support Web site:

http://www.hp.com/country/us/en/support.html?pageDisplay=drivers

Analog Resolution	Maximum Colors Supported	Maximum Refresh Rate
640 × 480	16.7 M	240 Hz
800 × 600	16.7 M	240 Hz
1024 x 768	16.7 M	240 Hz
1152 x 864	16.7 M	170 Hz
1280x1024	16.7 M	150 Hz
1600 × 1200	16.7 M	100 Hz
1920 × 1080	16.7 M	85 Hz
1920 × 1200	16.7 M	85 Hz
1920 × 1440	16.7 M	75 Hz
2048 x 1536	16.7 M	60 Hz
Digital Resolution	Maximum Colors Supported	Maximum Refresh Rate
640 × 480	16.7 M	75 Hz
800 × 600	16.7 M	75 Hz
1024 x 768	16.7 M	75 Hz
1152 x 864	16.7 M	60 Hz
1280 × 1024	16.7 M	60 Hz
1600 x 1200	16.7 M	60 Hz
1900 x 1200	16.7 M	60 Hz

ATX

Form Factor	ATX	
Graphic Controller	2 nv43 2D graphics processor units (GPUs)	
VGA controller	Integrated into the Quadro GPU	
Bus type	PCle x16	
RAMDAC	Dual 350 MHz	
Memory	256 MB DDR frame buffer and Texture storage (128MB per GPU)	
Connector	Two DMS-59	
Controller clock speed	250 MHz	
Color planes	32-bit color buffer	
Overlay planes	1 16-bit Video overlay plane	
Maximum pixel clock	350 MHz	
Multi-monitor support	Up to 4 analog or digital monitors	
Single DVI Support	Yes	
Dual DVI Support	Yes	



Technical Specifications – Peripherals

High-definition Video Processor (HDVP)	32-bit color 2048 x 1536 @ 60 Hz maximum resolution 2D rendering engine optimized for 32-, 24-, 16-, 15-, and 8-bpp modes
High-definition Video Processor (HDVP)	Full-screen, full-frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0) IDCT motion compensation 5-tap horizontal by 3-tap vertical filtering 8:1 up/down scaling
Available graphics drivers	 Microsoft Windows XP (Provides full native Dual View mode, Span or Big Desktop mode, and Clone mode) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/eng/software_drivers.html.

*NOTE: Graphics card uses "reduced blanking" timing and may not work with all panels at this resolution.

NVIDIA Quadro FX 560, 128 MB	Form Factor Graphics Controller Bus Type Memory Connectors	ATX NVIDIA NV73GL PCI-Express x16 128 MB 600 MHz GDDR3 SDRAM unified frame buffer, Z-buffer and Texture storage 2 DVI-I + 9-pin HDTV output
	Display resolution support	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link) and 3840x2400 (dual-link). NVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft® Windows®
	RAMDAC	Dual 400 MHz integrated
	Architecture features	128-bit memory interface 128-bit IEEE floating-point precision graphics pipeline 128-bit color precision 12-bit sub-pixel precision 8x FSAA at 1920x1200, 4x at 2048x1536, rotated grid FSAA sampling algorithm Hardware accelerated antialiased points and lines Hardware OpenGL overlay planes Hardware accelerated two-sided lighting Hardware accelerated clipping planes 3rd generation occlusion culling 3D volumetric texture support Quad-buffered stereo Single Link DVI enabling driving digital displays up to 1920x1200 (60Hz)



Technical Specifications – Peripherals	
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	Shading architecture Supported graphics APIs	Fully programmable GPU Long fragment programs (up to 65,536 instructions) Long vertex programs (up to 65,536 instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution OpenGL 2.0 DirectX 9.0	
	Available graphics drivers	Microsoft Windows XP Professional, Linux - Full Open GL implementation, complete with NVIDIA and ARB extensions. Qualified drivers may be preloaded or available from the HP support Web site: <u>http://welcome.hp.com/country/us/eng/software_drivers.html</u> .	
	Maximum Resolution	Dual DVI-I output – drives dual digital displays at resolutions up to 1920x1200 @ 60Hz.	
		Internal 400MHz RAMDACs – drives dual analog displays up to 2048x1536 @ 75Hz each	
ATI FireGL V3300, 128	Form Factor	ATX	
MB	Bus Type	PCI Express x16	
	RAMDAC	Dual 10-bit per channel 400 MHz	
	Memory	128 MB DDR unified frame buffer, Z-buffer and Texture storage	
	Connectors	Dual DVI-I analog/digital, dual VGA analog support with DVI-to-VGA adapters.	
	Display resolution support	Analog support for 2048x1536 @ 85 Hz on each output connector. Digital support for 1920x1200 @ 60 Hz on each output connector.	
	Ad	dditional product features	
	Image quality features	 2x/4x/6x Anti-aliasing modes; multi-sample algorithm with gamma correction, programmable sparse sample patterns, and centroid sampling 2x/4x/8x/16x Anisotrophic Filtering modes; up to 128-tap texture filtering High resolution texture support (up to 4K x 4K) Hardware supported overlays, antialiased points and lines, 2 sided lighting, occlusion culling 	
	Avivo video and display platform	 64-bit per pixel floating point HDR supported throughout the pipeline, includes support for blending and multi-sample antialiasing 32-bit integer HDR (10:10:10:2) format supported throughout the pipeline, includes support for blending and multi-sample antialiasing 	



Technical Specifico	ations – Peripherals	
	Programmable video processor	 Accelerated MPEG-2, MPEG-4, DiVX, WMV9, VC-1 and H.264 decoding and transcoding Seamless pixel shader integration with video in real-time
	Display output	 16-bit per channel floating point HDR and 10 bit per channel DVI output Programmable piecewise linear gamma correction, color correction, and color space conversion (10-bits per color) Complete independent color controls and video overlays for each display High quality pre- and post-scaling engineers with underscan support for all outputs Content-adaptive deflicker filtering for interlaced displays Spatial/temporal dithering enables 10-bit color quality on 8 and 6-bit displays VGA mode support on all outputs
	Shader Engine	 Supports Microsoft DirectX 9.0 Shader Model 3.0 programmable vertex and pixel shaders in hardware Full speed 128-bit floating point processing for all shader operations Dedicated branch-execution units for high performance dynamic branching and flow control Dedicated texture address units for improved efficiency Up to 128 simultaneous pixel threads Multiple Render Target (MRT) support Render to vertex buffer support
	Supported graphics APIs Available graphics drivers	OpenGL 2.0, Microsoft DirectX 9.0 HP-tested Windows XP HP-tested Linux HP qualified drivers may be preloaded or available from the HP support web site: http://h20000.www2.hp.com/bizsupport/TechSupport/ Product.jsp?prodTypeId=12454&prodCatId=296719&locale=en_US&tas kld=135
NVIDIA Quadro FX 1500, 256 MB	Form Factor Bus Type Memory	ATX PCI Express x16 256 MB 625 MHz GDDR3 SDRAM unified frame buffer, Z-buffer and Texture storage
	Connectors	2 dual-link DVI-I + 9-pin HDTV output



Technical Specifications – Peripherals

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	Display resolution support	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link) and 3840x2400 (dual-link). NVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft® Windows®
	RAMDAC	Dual 400 MHz integrated
	Architecture features	256-bit memory interface 128-bit IEEE floating-point precision graphics pipeline 128-bit color precision 12-bit sub-pixel precision 8x FSAA at 1920x1200, 4x at 2048x1536, rotated grid FSAA sampling algorithm Hardware accelerated antialiased points and lines Hardware OpenGL overlay planes Hardware accelerated two-sided lighting Hardware accelerated clipping planes 3rd generation occlusion culling 3D volumetric texture support Quad-buffered stereo Dual Link DVI enabling driving digital displays up to 3840x2400 (24Hz)
	Shading architecture	Fully programmable GPU Long fragment programs (up to 65,536 instructions) Long vertex programs (up to 65,536 instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution
	Supported graphics APIs	OpenGL 2.0 DirectX 9.0
	Available graphics drivers	Microsoft Windows XP Professional, Linux - Full Open GL implementation, complete with NVIDIA and ARB extensions. Qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/eng/software_drivers.html.
	Maximum Resolution	Dual DVI-I output – drives dual digital displays at resolutions up to 1920x1200 @ 60Hz (single-link) and 3840x2400 @ 24Hz (dual-link). Internal 400 MHz RAMDACs – drives dual analog displays up to 2048x1536 @ 75Hz each
ATI FireGL V7200, 256 MB	Form Factor Bus Type RAMDAC Memory	ATX PCI Express x16 Dual 10-bit per channel 400 MHz 256 MB GDDR3 graphics memory with unified frame buffer, Z-buffer and Texture storage and a 512-bit Ring-Bus memory controller



Connectors Display resolution support	Dual DVI-I analog/digital, dual VGA analog support with DVI-to-VGA adapters. The DVI-I digital connectors are Dual Link capable. Stereoscopi- 3D output connector with quad buffer support, HD Component Video (YPrPb) output with optional adapter. Analog support for 2048x1536 @ 85Hz on each output connector. Digital support for 1920 x1200 @ 60Hz on each output connector. Dual Link digital support for 2560 x 1600 @ 60Hz. Ideal for 30-inch	
	widescreen displays. NOTE: Stereo supported on single display only.	
Ad	dditional product features	
Ring Bus memory controller	512-bit internal ring bus for highly efficient memory reads Programmable intelligent arbitration logic	
Image quality features	 2x/4x/6x Anti-aliasing modes; multi-sample algorithm with gamma correction, programmable sparse sample patterns, and centroid sampling 	
	 2x/4x/8x/16x Anisotrophic Filtering modes; up to 128-tap texture filtering 	
	 High resolution texture support (up to 4K x 4K) Hardware supported overlays, antialiased points and lines, 2 sided lighting, occlusion culling 	
Avivo video and display platform	 64-bit per pixel floating point HDR supported throughout the pipeline, includes support for blending and multi-sample anti- aliasing 	
	• 32-bit integer HDR (10:10:10:2) format supported throughout the pipeline, includes support for blending and multi-sample anti- aliasing	
Programmable video processor	 Accelerated MPEG-2, MPEG-4, DiVX, WMV9, VC-1 and H.264 decoding and transcoding Seamless pixel shader integration with video in real-time 	
Display output	16-bit per channel floating point HDR and 10 bit per channel DVI output	
	Programmable piecewise linear gamma correction, color correction, and color space conversion (10-bits per color)	
	Complete independent color controls and video overlays for each display High quality pre- and post-scaling engineers with underscan support for all	
	outputs Content-adaptive de-flicker filtering for interlaced displays	
	Xilleon TV encoder for high quality analog support	
	Spatial/temporal dithering enables 10-bit color quality on 8 and 6-bit displays	
	VGA mode support on all outputs	



Technical Specifications – Peripherals

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	Shader Engine	 Supports Microsoft DirectX 9.0 Shader Model 3.0 programmable vertex and pixel shaders in hardware Full speed 128-bit floating point processing for all shader operations Dedicated branch-execution units for high performance dynamic branching and flow control Dedicated texture address units for improved efficiency Up to 512 simultaneous pixel threads Multiple Render Target (MRT) support Render to vertex buffer support
	Supported graphics APIs	OpenGL 2.0, Microsoft DirectX 9.0
	Available graphics drivers	 HP-tested Windows XP HP-tested Linux HP qualified drivers may be preloaded or available from the HP support web site: http://h20000.www2.hp.com/bizsupport/TechSupport/ Product.jsp?prodTypeId=12454&prodCatId=296719&locale=en_US&tas kId=135
NVIDIA Quadro FX	Form Factor	ATX
3500, 256 MB	Bus Type	PCI Express x16
	Memory	256 MB 700 MHz GDDR3 SDRAM unified frame buffer, Z-buffer and Texture storage
	Connectors	2 dual-link DVI-I + 3-pin Mini DIN stereo output
	Display resolution support	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link) and 3840x2400 (dual-link). NVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft® Windows®
	RAMDAC	Dual 400 MHz integrated
	Architecture features	 256-bit memory interface 128-bit IEEE floating-point precision graphics pipeline 128-bit color precision 12-bit sub-pixel precision 8x FSAA at 1920x1200, 4x at 2048x1536, rotated grid FSAA sampling algorithm Hardware accelerated antialiased points and lines Hardware OpenGL overlay planes Hardware accelerated two-sided lighting Hardware accelerated clipping planes 3rd generation occlusion culling 3D volumetric texture support Quad-buffered stereo



SLI Link

Dual Link DVI enabling driving digital displays up to 3840x2400 (24Hz)

Shading architecture	Fully programmable GPU Long fragment programs (up to 65,536 instructions) Long vertex programs (up to 65,536 instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution
Supported graphics APIs	OpenGL 2.0 DirectX 9.0
Available graphics drivers	Microsoft Windows XP Professional; Linux - Full Open GL implementation, complete with NVIDIA and ARB extensions. Qualified drivers may be preloaded or available from the HP support Web site: <u>http://welcome.hp.com/country/us/eng/software_drivers.html</u> .
Maximum Resolution	Dual DVI-1 output – drives dual digital displays at resolutions up to 1920x1200 @ 60Hz (single-link) and 3840x2400 @ 24Hz (dual-link). Internal 400MHz RAMDACs – drives dual analog displays up to 2048x1536 @ 75Hz each



Technical Specifications - Graphics

NVIDIA Quadro FX 4500, 512 MB with optional G-Sync	Bus type RAMDAC Memory Connectors	PCI Express x16 Dual 400 MHz integrated 512 MB GDDR3 SDRAM unified graphics memory 2 DVI-I analog/digital monitor outputs, 1 3-pin Mini DIN stereo output, DVI-I to VGA adapters included
	Display resolution support	Dual integrated display controllers supporting up to 2048x1536 @ 75Hz (analog) or 3840x2400 @ 41Hz (digital) on both displays
	NVIDIA Quadro FX 4500 architecture	
	Shading architecture	16 textures per pixel in fragment programs Window ID clipping functionality Hardware accelerated line stippling Fully programmable GPU (OpenGL2.0/DirectX 9.0c class) Long fragment programs (up to 65,536 instructions) Long vertex programs (up to 65,536 instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution
	High level shader languages	Optimized compiler for Cg and Microsoft® HLSL OpenGL 2.0 and DirectX 9.0c support Open source compiler
	High-resolution antialiasing	12-bit subpixel sampling precision enhances AA quality Rotated-grid full-scene antialiasing (RG FSAA) 16x FSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920x1200
	Display resolution support	
	nView architecture	Advanced multi-display desktop & application management seamlessly integrated into Microsoft Windows®.



Technical Specifications - Graphics

Optional G-Sync Delivers Frame lock/Genlock functionality to unprecedented levels of industrial realism, visualization and collaborative capabilities. Frame lock allows the display channels from multiple workstations to be synchronized, thus creating one large "virtual display" that can be driven by a multisystem cluster for performance scalability, while Genlock allows the graphics output to be synchronized to an external source, typically for film and broadcast video applications. The NVIDIA Quadro G-Sync requires an NVIDIA Quadro FX 4500 graphics controller and an available expansion slot. Supported graphics APIs OpenGL 2.0 ICD with immediate mode support for all OGL primitive types DirectX 9.0c Available graphics drivers Microsoft Windows XP, Linux - Full Open GL implementation, complete with NVIDIA and ARB extensions. HP qualified drivers may be preloaded or available from the HP support web site: http://welcome.hp.com/country/us/eng/software_drivers.html

	N	-	
HP L1955 Flat Panel Monitor	Panel	Туре	Active matrix, thin film transistor (TFT)
Momor		Viewable Image Area (diagonal)	19 in (48.25 cm) maximum viewable
		Screen Opening ($W \times H$)	14.9 x 12.0 in (38.0 x 30.5 cm)
		Viewing Angle (typical)	176 degrees horizontal/176 degrees vertical (10:1 minimum contrast ratio)
		Brightness (typical)	Up to 250 nits (cd/m²)
		Contrast Ratio (typical)	Up to 1000:1 (typical)
		Response Rate (typical)	<16 ms (typical rise + fall)
		Pixel Pitch	0.294 mm
		Color Depth Support	16.7 million colors
	Video/Other Inputs	Plug and Play	Yes (supports VESA DDC2B; PC2001 compliant)
		Self Powered USB 2.0 Hub	One upstream, four downstream ports (cable included)
		Input Signal	Two connectors: one 15-pin mini D-sub analog VGA; and one DVI-I (VGA analog or digital)
		Input Impedance	75 ohms ± 2%
		Sync Input	Separate sync (HSYNC/VSYNC); composite sync, Sync on Green (activated through on- screen display)
		Video Cable	VGA to VGA, DVI-D to DVI-D, and DVI-I to VGA
		Video Cable Length	78 in (2.0 m)
	Signal Interface/	Horizontal Frequency	30 to 82 kHz
	Performance	Vertical Frequency	56 to 75 Hz
		Native Resolution	1280 x 1024 @ 75 Hz analog
			1280 x 1024 @ 60 Hz digital
		Maximum Resolution (Analog)	1280 x 1024 @ 75 Hz analog
		Maximum Resolution (Digital)	1280 x 1024 @ 75 Hz digital
		Preset VESA Graphic Modes (non-interlaced)	640 x 480 @ 60 Hz, 72 Hz, 75 Hz 720 x 400 @ 70 Hz
			800 x 600 @ 60 Hz, 72 Hz, 75 Hz
			1024 x 768 @ 60 Hz, 70 Hz, 75 Hz 1280 x 1024 @ 60 Hz, 75 Hz
		Preset MAC Mode	832 x 624 @ 75 Hz
			1152 x 870 @75 Hz
		Preset VGA Mode	640 x 480 @ 60 Hz, 72 Hz
		Preset SUN Mode	1152 x 900 @ 76 Hz
		Fail Safe Mode	Yes (limits out of range signal messages)



	Maximum Pixel Clock Speed	140 MHz
	' User Programmable Modes	Yes, 15
	Anti-Glare	Yes
	Anti-Static	Yes
	AssetControl	Yes (accessible on HP Compaq Business Desktops featuring Intelligent Manageability)
	Default Color Temperature	Yes (6500k, 9300k, SRGB, Custom User)
On Screen Display (OSD) Controls	Buttons or Switches	Power on/off; 3-button OSD; second level OSD buttons include dual-input switch, dedicated auto adjust switch
	Languages	English, Spanish, French, German, Italian, Japanese, Simplified Chinese
	User Controls	Size and Positioning
		Contrast
		Brightness
		Clock, Clock Phase
		Selectable Color Temperature
		Serial Number
		Mode Displayed
		Sleep Timer
		Input Selection
		Factory Reset
		Individual Color Contrast
		Full-screen Resolution
Power	Power Supply	Auto-ranging, 90 to 265 VAC; internal power supply
	Input Power	100 ~ 240 VAC
	Nominal Current	1.5 A maximum
	Frequency	50 ~ 60 Hz
	Average	33 watts when displaying standard office software
	Typical Power Consumption	< 40 watts
	Maximum	< 60 watts
	Power Saving	< 2 watts
	Off Mode	O watts (when master power switch is in the off position)
	Power Cable Length	70 in (1.8 m); non-captive



Technical Specifications - Monitors				
	Mechanical	$\begin{array}{l} \text{Dimensions} \\ (H \times W \times D) \end{array}$	Unpacked with stand	16.8 (minimum) to 22.3 (maximum) x 15.9 x 8.3 in (42.7 (minimum) to 56.6 (maximum) x 40.4 x 21.1 cm)
			Base Area (Footprint D × ₩)	8.3 x 12.2 in (21.1 x 30.9 cm)
			Panel only (without stand) (H × W × D)	$13.2 \times 15.9 \times 3.1$ in (33.5 × 40.4 × 7.9 cm)
		Weight	Unpacked with stand	16.5 lb (7.5 kg)
		-	Unpacked without stand	10.5 lb (4.75 kg)
			Packaged	23.5 lb (10.7 kg)
		Bezel Width	13 mm left and right, bottom	14 mm top, and 15 mm
		Tilt Range	-5° to +35°	
		Swivel Range	± 50° horizontal swive	el
		Height Adjustable	Yes (5.1 in/13 cm ac	djustment range)
		Pivot Rotation	Yes, 90 °	
		Base	Ships detached and is installation	removable after
	Environmental	Temperature – Operating	41° to 95° F (5° to 3	5°C)
		Temperature – Non- operating	-4° to 140° F (-20° to	60° C)
		Humidity – Operating	20% to 80%	
		Humidity – Non-operating	5% to 95%	
		Altitude – Operating	0 to 13,000 ft (0 to 4	,000 m)
		Altitude – Non-operating	0 to 40,000 ft (0 to 1	2,192 m)
	Options	Desktop Access Center	dual function headset MultiBay slot for addir separately), and four U	ty digital solutions. Sold er DK985A. For more
		HP Flat Panel Speaker Bar	attaches to the monitor multimedia support to monitors. Features duc range and external jac separately, part number	r's bezel to bring full



	Other	Accessories Included	VGA to VGA cable, DVI-D to DVI-D cable, DVI-I to VGA cable, USB cable, user CD-ROM with Pivot Pro software
		Software	Pivot Pro software from Portrait Displays, Inc. interacts with your PC's native graphics driver to enable seamless portrait screen redraws with a simple mouse-click or keyboard command. Pivot Pro supports 90-degree portrait and landscape views. Language support is available in English, Japanese, French, German, Spanish, Italian, and Traditional and Simplified Chinese.
		Software	HP Display LiteSaver feature lets you schedule Sleep mode at preset times to help protect the display against image retention, drastically lower power consumption and energy costs, and extend the lifespan of the monitor.
		User Guide Languages	English
		Warranty Languages	English
		Color	Carbonite, two-tone carbonite and silver (EMEA only)
		VESA Mounting	Yes (swing arm/wall mount not included); base must be removed for mounting options)
		VESA External Mounting	Yes (standard 4 hole pattern, 100 mm)
		Kensington Lock-ready	Yes
	Certification and Compliance	China CCIB/CCEE Appl Approvals, Energy Star C (TUV and GS Mark), ISO Mexican NOM Approva Certified, S. Korean MIC 03 depending on region	, Canadian Requirements/CSA, CE Marking, roval, CISPR Requirements, Eastern European Compliant, FCC Approval, German Ergonomic 13406-2 Compliant (Pixel Defect Guidelines), I, MPR-II Compliant, PC2001 Compliant, PC99 Approval, Taiwan BSMI Approval, TCO 99 or (emissions, ergonomics, environment), TUV-Ergo, Is, Microsoft® Windows® Certification
	Compatibility	9	lard (VSIS) Compliant video cards have been atible for use with the HP L1955 Flat Panel for use with HP products.
	Service and Warranty	site service. Next Busines service available during v	nd repair labor, service provider labor, and on- s Day advanced exchange direct replacement warranty period. Certain restrictions and ails, contact HP Customer Support.
HP Flat Panel Monitor	Panel	Туре	20-inch Active Matrix TFT (thin film transistor)

LP2065

Panel

Туре Viewable Image Area (diagonal)

20-inch Active Matrix TFT (thin tilm transistor) 20.1 in (51 cm)



	Screen Opening $(W \times H)$	16.2 x 12.17 in (41.1 x 30.9 cm)
	Viewing Angle (typical)*	Up to 178° horizontal/178° vertical (10:1 minimum contrast ratio)
	Brightness (typical*	Up to 300 nits (cd/m2)
	Contrast Ratio (typical)*	Up to 800:1
	Response Rate (typical)*	8 ms (gray to gray), 16 ms (rise + fall)
	Pixel Pitch	0.255 mm
	Color Depth Support	16.7 million colors
	Backlight Lamp Life (to half brightness)	45K hours
On Screen Display (OSD) Controls	Buttons or Switches	Input select, auto adjust/OSD up, OSD down, OSD menu select, power
	Languages	English, French, German, Spanish, Italian, Dutch, and Japanese
	User Controls	Brightness, contrast, positioning, color temperature, individual color control, serial number display, full screen resolutions, clock, clock phase, input selection, image control (including scaling), and factory reset
Signal Interface/ Performance	Horizontal Frequency	30 to 94 kHz (VGA input); 30 to 92 KHz (DVI input for modes with pixel clock less than 157 MHz)
	Vertical Frequency	48 to 85 Hz (VGA input); 30 to 92 KHz (DVI input for modes with pixel clock less than 157 MHz)
	Native Resolution	1600 x 1200 @ 60 Hz (recommended)
	Preset VESA Graphic Modes (non-interlaced)	1600 x 1200 @ 60 Hz, 75 Hz (VGA input) 1280 x 1024 @ 60 Hz, 75 Hz, 85 Hz 1280 x 960 @ 60 Hz 1152 x 900 @ 66 Hz 1024 x 768 @ 60 Hz, 75 Hz, 85 Hz 800 x 600 @ 60 Hz, 85 Hz 640 x 480 @ 60 Hz, 75 Hz, 85 Hz
	Text Mode	720 x 400 @ 70 Hz
	Mac Mode	1152 x 870 @ 75 Hz and 832 x 624 @ 75 Hz
	Sun Mode	1152 x 900 @ 66 Hz
	Maximum Pixel Clock Speed	202 MHz (VGA input); 162 MHz (DVI input)
	User Programmable Modes	Yes, 10
	Anti-Glare	Yes



	Anti-Static	Yes	
	Default Color Temperature		
Video Input	Plug and Play	Yes	
	Input Signal	Four connectors, includi sub VGA, one DVI-I (VG input), one composite v	A analog and digital
	Self Powered USB 2.0 Hub	One upstream, four dov included)	wnstream ports (cable
	Input Signal	Two DVI-I connectors (d digital input possible)	ual VGA analog or dual
	Input Impedance	75 ohms ± 10%	
	Sync Input	Separate sync (HSYNC sync, Sync on Green	:/VSYNC); composite
	Video Cable	Two VGA to DVI-I; two	DVI-D to DVI-I
	Video Cable Length	5.9 ft (1.8 m)	
Power	Input Power	Auto-Ranging, 90 to 13 265 VAC; internal pow Hz	
	Frequency	47.5 to 63 Hz	
	Typical Power Consumption	55 watts (without USB ports fully loaded)	oorts); 70 watts (USB
	Maximum	< 75 W	
	Power Saving	< 2 watts	
	Power Cable Length	5.9 ft (1.8 m)	
Mechanical	Dimensions (H \times W \times D)	Unpacked with stand	16.7 to 21.8 x 17.4 x 8.67 in (42.5 to 55.5 x 44.3 x 22.0 cm)
		Unpacked w/o stand (head only)	13.58 x 17.4 x 3.42 in (34.5 x 44.3 x 8.7 cm)
		Packaged	11.77 x 22.2 x 16.77 in (29.9 x 56.4 x 42.6 cm)
	Weight	Unpacked	With stand: 20.28 lb (9.2 kg); Without stand: 12.35 lb (5.6 kg)
		Packaged	26.3 lb (11.95 kg)
	Tilt Range	-5° to + 25° vertical tilt	
	Swivel Range	-45° to + 45°	
	Height Adjustable	Yes, range 5.1 in (13.0	Эст)



HP xw6400 Workstation

	Pivot Rotation	Yes
	Base	Detachable, ships attached
Environmental	Temperature – Operating	46° to 95° F (10° to 35° C)
	Temperature – Non- operating	6° to 140° F (-10° to 60° C)
	Humidity – Operating	20% to 80% non-condensing
	Humidity – Non-operating	5% to 85%
	Altitude – Operating	+12,000 ft (+3,657.6 m)
	Altitude – Non-operating	+40,000 ft (+12,192 m)
Options	HP Silver Flat Panel Speaker Bar - Part number: EE418AA	Powered directly by the monitor or the PC, the Speaker Bar seamlessly attaches to the monitor's lower bezel to bring full audio support
		to select HP flat panel monitors. Features include dual speakers with full sound range and external jack for headphones. Sold separately. For more information, refer to the HP Silver Flat Panel Speaker Bar QuickSpec.
Other	Accessories Included	VGA to DVI-I cable - connects the graphic card's VGA connector to the monitor's input #1 or 2 (DVI-I analog) connector.
		DVI-D to DVI-I cable - connects the graphic card's DVI-D digital connector to the monitor's input #1 or #2 (DVI-I digital) connector.
	User Guide Languages	English, B. Portuguese, French, LA Spanish, Korean, S. Chinese, T. Chinese, Bahasa, Japanese, Danish, Finnish, German, Norwegian, Spanish, Swedish, Greek, Polish, Russian, Slovenian, Turkish
	Software	HP Display Assistant Utility makes it possible to adjust displays settings through the PC using two-way communication via DDCI.
		HP Display Lite Saver allows ability to power up and down display at predetermined hours of the day to safe power and backlight life.
		Pivot Pro software from Portrait Displays, Inc. interacts with your PC's native graphics driver to enable seamless portrait screen redraws with a simple mouse-click or keyboard command. Pivot Pro supports 90-degree portrait and landscape views. Language support is available in English, Japanese, French, German, Spanish, Italian, and Traditional and Simplified Chinese.
	User Guide Languages Warranty Languages Color	English English Carbonite/Silver



Technical Specifications - Monitors

	VESA External Mounting Yes (Standard 4 hole pattern, 100 mm)		
	Kensington Lock-Ready Yes		
Certification and Compliance	Canadian Requirements/CSA, CE Marking, CISPR Requirements, , Energy Star Compliant, FCC Approval, ISO 13406-2 Pixel Defect Guidelines, Mexican NOM Approval,, MPR-II Compliant, PC2001 Compliant, PC99 Certified, TCO 03 (emissions, ergonomics, environment), TUV-Ergo, UL Listed, VCCI Approvals, Microsoft® Windows® Certification (Microsoft® Microsoft Windows XP)		
Compatibility	Compatible with platforms using the VESA standard video modes. Recommended for use with HP products.		
Service and Warranty	Three years parts, labor, and on-site service. 24-hour 365-day 1-800 technical support. Replacement options include 2nd business day on-site service or next business day direct replacement. With direct replacement, HP will ship a replacement display product directly to you. Using the shipping labels provided, return your failed display to HP. Certain restrictions and exclusions apply. For details, contact HP Customer Support.		

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